

# PRODUCT/PROCESS CHANGE NOTIFICATION

PCN APM-IPC/10/5880 Notification Date 09/08/2010

L6563S (UE39 LINE) and L6563H (MV59 LINE): METAL MASK CHANGE

### **Table 1. Change Implementation Schedule**

Forecasted implementation date for change	01-Sep-2010
Forecasted availabillity date of samples for customer	01-Sep-2010
Forecasted date for <b>STMicroelectronics</b> change Qualification Plan results availability	01-Sep-2010
Estimated date of changed product first shipment	20-Dec-2010

### **Table 2. Change Identification**

Product Identification (Product Family/Commercial Product)	L6563S/L6563STR and L6563H/L6563HTR
Type of change	Product electrical spec. change
Reason for change	Better performing products
Description of the change	We have introduced a metal mask modification on the UE39 wafer, in order to: improve the noise immunity during load transient and avoid false protection triggering; get a better behavior during the ON-OFF-ON transients.
Product Line(s) and/or Part Number(s)	See attached
Description of the Qualification Plan	See attached
Change Product Identification	New internal part numbers
Manufacturing Location(s)	

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Tahla	3 I	liet of	Attack	nments

Customer Part numbers list	
Qualification Plan results	

PCN APM-IPC/10/5880
Notification Date 09/08/2010
Name:
Title:
Company:
Date:
Signature:

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### **DOCUMENT APPROVAL**

Name	Function
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**A7**/.

### ATTACHMENT TO PCN APM-IPC/10/5880

#### WHAT:

We have modified the Feedback Disconnection Protection. **BEFORE** the signal was monitored as voltage difference between pin INV and pin PFC\_OK. **NOW** the signal is monitored as voltage on pin INV only. (See pages 1 and 12 for L6563S attached datasheet and pages 1 and 13 for L6563H attached datasheet).

We have modified the signal monitored to stop the Voltage Feed Forward discharge. **BEFORE** it was the voltage at pin VFF. **NOW** it is the voltage at pin RUN. (See description on page 25 for L6563S attached datasheet and on page 26 for L6563H attached datasheet).

#### WHY:

To improve the noise immunity during load transient and to avoid false protection triggering.

To get a better behavior during the ON-OFF-ON transients.

#### HOW:

Through metal mask modification.

The new version will be identified by our internal part numbers, as follows:

Commercial Product	Old internal part number	New internal part number
L6563S	L6563S-4/	L6563S-5/
L6563STR	L6563STR-4/	L6563STR-5/
L6563H	L6563H-4/	L6563H-5/
L6563HTR	L6563HTR-4/	L6563HTR-5/

The qualification program mainly consists of comparative electrical yield and application bench trials. The validation report is available upon request.

This change does not affect any conditions related to the reliability of the product, so you can refer to the original Reliability Report.

#### WHEN:

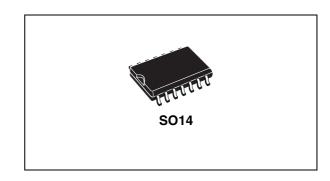
We will start shipping the new product from the end of Q4 onwards. Samples are available and can be delivered upon request.



### Enhanced transition-mode PFC controller

### **Features**

- Tracking boost function
- Fast "bidirectional" input voltage feedforward (1/V<sup>2</sup> correction)
- Interface for cascaded converter's PWM controller
- Remote ON/OFF control
- Accurate adjustable output overvoltage protection
- Protection against feedback loop disconnection (latched shutdown)
- Inductor saturation protection
- Low (≤ 100 µA) start-up current
- 6 mA max. operating bias current
- 1% (@ T<sub>J</sub> = 25 °C) internal reference voltage
- -600/+800 mA totem pole gate driver with active pull-down during UVLO
- SO14 package

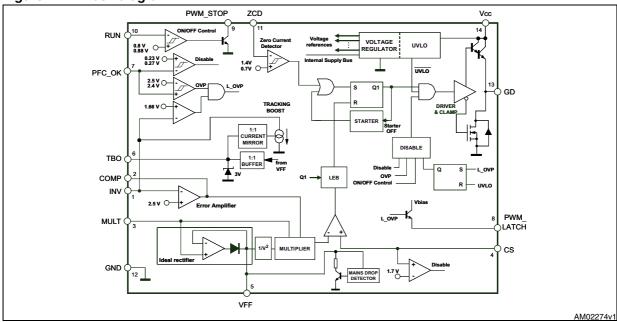


# **Applications**

PFC pre-regulators for:

- High-end AC-DC adapter/charger
- Desktop PC, server, Web server
- IEC61000-3-2 or JEITA-MITI compliant SMPS, in excess of 400 W





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Device description L6563S

## 1 Device description

The L6563S is a current-mode PFC controller operating in transition mode (TM). Coming with the same pin-out as its predecessor L6563, it offers improved performance and additional functions.

The highly linear multiplier, along with a special correction circuit that reduces crossover distortion of the mains current, allows wide-range-mains operation with an extremely low THD even over a large load range.

The output voltage is controlled by means of a voltage-mode error amplifier and an accurate (1% @  $T_J = 25$  °C) internal voltage reference. Loop's stability is optimized by the voltage feedforward function (1/ $V^2$  correction), which in this IC uses a proprietary technique that considerably improves line transient response as well in case of mains both drops and surges ("bidirectional").

Additionally, the IC provides the option for tracking boost operation, i.e. the output voltage is changed tracking the mains voltage.

The device includes disable functions suitable for remote ON/OFF control both in systems where the PFC pre-regulator works as a master and in those where it works as a slave. In addition to an overvoltage protection able to keep the output voltage under control during transient conditions, the IC is provided also with a protection against feedback loop failures or erroneous settings. Other on-board protection functions allow that brownout conditions and boost inductor saturation can be safely handled.

An interface with the PWM controller of the DC-DC converter supplied by the PFC preregulator is provided: the purpose is to stop the operation of the converter in case of anomalous conditions for the PFC stage (feedback loop failure, boost inductor's core saturation, etc.) and to disable the PFC stage in case of light load for the DC-DC converter, so as to make it easier to comply with energy saving norms (Blue Angel, EnergyStar, Energy2000, etc.).

The totem-pole output stage, capable of 600 mA source and 800 mA sink current, is suitable for big MOSFET or IGBT drive. This, combined with the other features and the possibility to operate with ST's proprietary Fixed-Off-Time control, makes the device an excellent solution for SMPS up to 400 W that need to be compliant with EN61000-3-2 and JEITA-MITI standards.

L6563S Maximum ratings

# 2 Maximum ratings

# 2.1 Absolute maximum ratings

Table 1. Absolute maximum ratings

Symbol	Pin	Parameter	Value	Unit
Vcc	14	IC supply voltage (Icc = 20 mA)	self-limited	V
	1, 3, 7	Max. pin voltage (I <sub>pin</sub> =1 mA)	Self-limited	V
	2, 4 to 6, 8, 10	Analog inputs and outputs	-0.3 to 8	٧
V <sub>PWM_STOP</sub>	9	Analog output	-0.3 to Vcc	V
I <sub>PWM_STOP</sub>	9	Max. sink current	3	mA
I <sub>ZCD</sub>	11	Zero current detector max. current	-10 (source) 10 (sink)	mA
VFF pin	5	Maximum withstanding voltage range	+/- 1250	٧
Other pins 1 to 4 6 to 14	test condition: CDF-AEC-Q100-002 "human body model" Acceptance criteria: "normal performance"	+/- 2000	V	

### 2.2 Thermal data

Table 2. Thermal data

Symbol	Parameter	Value	Unit
R <sub>thJA</sub>	Max. thermal resistance, junction-to-ambient	120	°C/W
Ptot	Power dissipation @T <sub>A</sub> = 50 °C	0.75	W
T <sub>J</sub>	Junction temperature operating range	-40 to 150	°C
T <sub>stg</sub>	Storage temperature	-55 to 150	°C

Pin connection L6563S

# 3 Pin connection

Figure 2. Pin connection

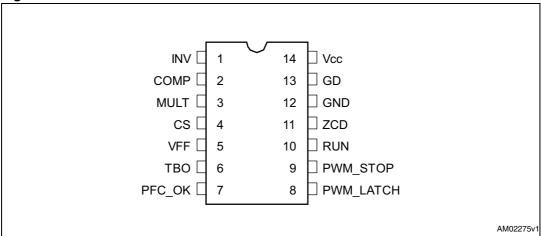


Table 3. Pin description

n°	Name	Function
1	INV	Inverting input of the error amplifier. The information on the output voltage of the PFC pre- regulator is fed into the pin through a resistor divider.  The pin normally features high impedance but, if the tracking boost function is used, an internal current generator programmed by TBO (pin 6) is activated. It sinks current from the pin to change the output voltage so that it tracks the mains voltage.
2	СОМР	Output of the error amplifier. A compensation network is placed between this pin and INV (pin 1) to achieve stability of the voltage control loop and ensure high power factor and low THD. To avoid uncontrolled rise of the output voltage at zero load, when the voltage on the pin falls below 2.4 V the gate driver output will be inhibited (burst-mode operation).
3	MULT	Mains input to the multiplier. This pin is connected to the rectified mains voltage via a resistor divider and provides the sinusoidal reference to the current loop. The voltage on this pin is used also to derive the information on the RMS mains voltage.
4	CS	Input to the PWM comparator. The current flowing in the MOSFET is sensed through a resistor, the resulting voltage is applied to this pin and compared with an internal reference to determine MOSFET's turn-off.  A second comparison level at 1.7 V detects abnormal currents (e.g. due to boost inductor saturation) and, on this occurrence, activates a safety procedure that temporarily stops the converter and limits the stress of the power components.
5	VFF	Second input to the multiplier for $1/V^2$ function. A capacitor and a parallel resistor must be connected from the pin to GND. They complete the internal peak-holding circuit that derives the information on the RMS mains voltage. The voltage at this pin, a dc level equal to the peak voltage on pin MULT (3), compensates the control loop gain dependence on the mains voltage. Never connect the pin directly to GND but with a resistor ranging from $100 \text{ k}\Omega$ (minimum) to $2 \text{ M}\Omega$ (maximum).
6	ТВО	Tracking boost function. This pin provides a buffered VFF voltage. A resistor connected between this pin and GND defines a current that is sunk from pin INV (#1). In this way, the output voltage is changed proportionally to the mains voltage (tracking boost). If this function is not used leave this pin open.

L6563S Pin connection

Table 3. Pin description (continued)

n°	Name	Function
7	PFC_OK	PFC pre-regulator output voltage monitoring/disable function. This pin senses the output voltage of the PFC pre-regulator through a resistor divider and is used for protection purposes. If the voltage on the pin exceeds 2.5 V the IC stops switching and restarts as the voltage on the pin falls below 2.4 V. However,if at the same time the voltage of the INV pin falls below 1.66V, a feedback failure is assumed. In this case the device is latched off and the pin PWM_LATCH (#8) is asserted high. Normal operation can be resumed only by cycling Vcc bringing its value lower than 6V before to move up the Turn on threshold. If the voltage on this pin is brought below 0.23 V the IC is shut down. To restart the IC the voltage on the pin must go above 0.27 V. This can be used as a remote on/off control input.
8	PWM_LATCH	Output pin for fault signaling. During normal operation this pin features high impedance. If a feedback failure is detected (PFC_OK > 2.5 V and INV< 1.66V) the pin is asserted high. Normally, this pin is used to stop the operation of the dc-dc converter supplied by the PFC preregulator by invoking a latched disable of its PWM controller. If not used, the pin will be left floating.
9	PWM_STOP	Output pin for fault signaling. During normal operation this pin features high impedance. If the IC is disabled by a voltage below 0.8 V on pin RUN (#10) the voltage on the pin is pulled to ground. Normally, this pin is used to temporarily stop the operation of the dc-dc converter supplied by the PFC pre-regulator by disabling its PWM controller. A typical usage of this function is brownout protection in systems where the PFC pre-regulator is the master stage. If not used, the pin will be left floating.
10	RUN	Remote ON/OFF control. A voltage below 0.8V shuts down (not latched) the IC and brings its consumption to a considerably lower level. PWM_STOP is asserted low. The IC restarts as the voltage at the pin goes above 0.88 V. Connect this pin to pin VFF (#5) either directly or through a resistor divider to use this function as brownout (AC mains undervoltage) protection.
11	ZCD	Boost inductor's demagnetization sensing input for transition-mode operation. A negative-going edge triggers MOSFET's turn-on.
12	GND	Ground. Current return for both the signal part of the IC and the gate driver.
13	GD	Gate driver output. The totem pole output stage is able to drive power MOSFET's and IGBT's with a peak current of 600 mA source and 800 mA sink. The high-level voltage of this pin is clamped at about 12 V to avoid excessive gate voltages.
14	Vcc	Supply voltage of both the signal part of the IC and the gate driver. Sometimes a small bypass capacitor (0.1 $\mu$ F typ.) to GND might be useful to get a clean bias voltage for the signal part of the IC.

Pin connection L6563S

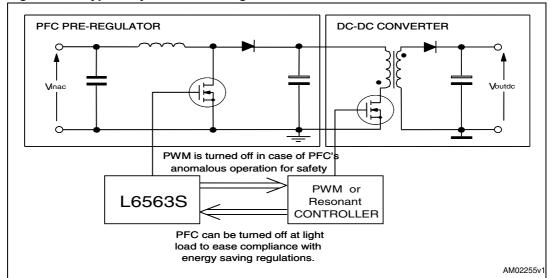


Figure 3. Typical system block diagram

# 4 Electrical characteristics

 $T_J$  = -25 to 125 °C,  $V_{CC}$  = 12 V,  $C_O$  = 1 nF between pin GD and GND,  $C_{FF}$  = 1  $\mu F$  and  $R_{FF}$  = 1  $M\Omega$  between pin VFF and GND; unless otherwise specified.

Table 4. Electrical characteristics

Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit
Supply voltage						
Vcc	Operating range	After turn-on	10.3		22.5	V
Vcc <sub>On</sub>	Turn-on threshold	(1)	11	12	13	V
Vcc <sub>Off</sub>	Turn-off threshold	(1)	8.7	9.5	10.3	٧
Vcc <sub>restart</sub>	Vcc for resuming from latch	OVP latched	5	6	7	V
Hys	Hysteresis		2.3		2.7	V
V <sub>Z</sub>	Zener voltage	Icc = 20 mA	22.5	25	28	V
Supply cur	rent					
I <sub>start-up</sub>	Start-up current	Before turn-on, Vcc = 10 V		90	150	μΑ
Iq	Quiescent current	After turn-on, V <sub>MULT</sub> = 1 V		4	5	mA
I <sub>CC</sub>	Operating supply current	@ 70 kHz		5	6.0	mA
1	Idle state quiescent current	V <sub>PFC_OK</sub> > V <sub>PFC_OK_S</sub> AND V <sub>INV</sub> < V <sub>PFC_OK</sub> - V <sub>FFD</sub>		180	280	μA
I <sub>qdis</sub>		V <sub>PFC_OK</sub> < V <sub>PFC_OK_D</sub> OR V <sub>RUN</sub> < V <sub>DIS</sub>		1.5	2.2	mA
I <sub>q</sub>	Quiescent current	V <sub>PFC_OK</sub> > V <sub>PFC_OK_S</sub> OR V <sub>COMP</sub> < 2.3 V		2.2	3	mA
Multiplier i	nput					
I <sub>MULT</sub>	Input bias current	V <sub>MULT</sub> = 0 to 3 V		-0.2	-1	μΑ
V <sub>MULT</sub>	Linear operation range		0 to 3			V
V <sub>CLAMP</sub>	Internal clamp level	I <sub>MULT</sub> = 1 mA	9	9.5		V
$\Delta V_{CS}$ $\Delta V_{MULT}$	Output max. slope	V <sub>MULT</sub> =0 to 0.4 V, V <sub>VFF</sub> = 0.8 V V <sub>COMP</sub> = Upper clamp	2.2	2.34		V/V
K <sub>M</sub>	Gain <sup>(2)</sup>	V <sub>MULT</sub> = 1 V, V <sub>COMP</sub> = 4 V	0.375	0.45	0.525	1/V
Error ampli	ifier		<b>'</b>		·	l
.,	Voltage feedback input threshold	T <sub>J</sub> = 25 °C	2.475	2.5	2.525	.,
V <sub>INV</sub>		10.3 V < Vcc < 22.5 V <sup>(3)</sup>	2.455		2.545	V
	Line regulation	Vcc = 10.3 V to 22.5 V		2	5	mV
I <sub>INV</sub>	Input bias current	TBO open, V <sub>INV</sub> = 0 to 4 V		-0.2	-1	μΑ
V <sub>INVCLAMP</sub>	Internal clamp level	I <sub>INV</sub> = 1 mA	8	9		V

Electrical characteristics L6563S

Table 4. Electrical characteristics (continued)

Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit
Gv	Voltage gain	Open loop	60	80		dB
GB	Gain-bandwidth product			1		MHz
	Source current	V <sub>COMP</sub> = 4 V, V <sub>INV</sub> = 2.4 V	2	4		mA
I <sub>COMP</sub>	Sink current	V <sub>COMP</sub> = 4 V, V <sub>INV</sub> = 2.6 V	2.5	4.5		mA
	Upper clamp voltage	I <sub>SOURCE</sub> = 0.5 mA	5.7	6.2	6.7	
V <sub>COMP</sub>	Burst-mode voltage	(3)	2.3	2.4	2.5	V
	Lower clamp voltage	I <sub>SINK</sub> = 0.5 mA <sup>(3)</sup>	2.1	2.25	2.4	
Current sei	nse comparator					
I <sub>CS</sub>	Input bias current	V <sub>CS</sub> = 0			1	μΑ
t <sub>LEB</sub>	Leading edge blanking		100	150	250	ns
td <sub>(H-L)</sub>	Delay to output		100	200	300	ns
V <sub>CSclamp</sub>	Current sense reference clamp	V <sub>COMP</sub> = Upper clamp, V <sub>MULT</sub> =1 V V <sub>VFF</sub> = 1 V	1.0	1.08	1.16	٧
Vaa	Current sense offset	V <sub>MULT</sub> = 0, V <sub>VFF</sub> = 3 V		40	70	>/
Vcs <sub>ofst</sub>		V <sub>MULT</sub> = 3 V, V <sub>VFF</sub> = 3 V		20		mV
Boost indu	ctor saturation detector		1			
V <sub>CS_th</sub>	Threshold on current sense	(3)	1.6	1.7	1.8	V
I <sub>INV</sub>	E/A input pull-up current	After V <sub>CS</sub> > V <sub>CS_th</sub> , before restarting	5	10	13	μΑ
PFC_OK fu	nctions					•
I <sub>PFC_OK</sub>	Input bias current	V <sub>PFC_OK</sub> = 0 to 2.6 V		-0.1	-1	μΑ
V <sub>PFC_OK_C</sub>	Clamp voltage	I <sub>PFC_OK</sub> = 1 mA	9	9.5		V
V <sub>PFC_OK_S</sub>	OVP threshold	<sup>(1)</sup> voltage rising	2.435	2.5	2.565	V
V <sub>PFC_OK_R</sub>	Restart threshold after OVP	<sup>(1)</sup> voltage falling	2.34	2.4	2.46	V
V <sub>PFC_OK_D</sub>	Disable threshold	<sup>(1)</sup> voltage falling	0.12		0.35	V
V <sub>PFC_OK_D</sub>	Disable threshold	<sup>(1)</sup> voltage falling T <sub>J</sub> = 25 °C	0.17	0.23	0.29	V
V <sub>PFC_OK_E</sub>	Enable threshold	<sup>(1)</sup> voltage rising	0.15		0.38	V
V <sub>PFC_OK_E</sub>	Enable threshold	<sup>(1)</sup> voltage rising Tj = 25 °C	0.21	0.27	0.32	V
V <sub>FFD</sub>	Feedback failure detection threshold (V <sub>INV</sub> falling)	V <sub>PFC_OK</sub> > V <sub>PFC_OK_S</sub>	1.61	1.66	1.71	mV
Zero currer	nt detector	-			•	•
V <sub>ZCDH</sub>	Upper clamp voltage	I <sub>ZCD</sub> = 2.5 mA	5.0	5.7		٧
V <sub>ZCDL</sub>	Lower clamp voltage	I <sub>ZCD</sub> = - 2.5 mA	-0.3	0	0.3	٧
V <sub>ZCDA</sub>	Arming voltage (positive-going edge)		1.1	1.4	1.9	٧

Table 4. Electrical characteristics (continued)

Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit
V <sub>ZCDT</sub>	Triggering voltage (negative-going edge)		0.5	0.7	0.9	٧
I <sub>ZCDb</sub>	Input bias current	V <sub>ZCD</sub> = 1 to 4.5 V			1	μΑ
I <sub>ZCDsrc</sub>	Source current capability		-2.5	-4		mA
I <sub>ZCDsnk</sub>	Sink current capability		2.5	5		mA
Tracking be	oost function					
ΔV	Dropout voltage VVFF-VTBO	I <sub>TBO</sub> = 0.2 mA	-20		20	mV
I <sub>TBO</sub>	Linear operation		0		0.2	mA
	I <sub>INV</sub> -I <sub>TBO</sub> current mismatch	$I_{TBO} = 25 \mu A \text{ to } 0.2 \text{mA}$	-5.5		+1.0	%
	I <sub>INV</sub> -I <sub>TBO</sub> current mismatch	$I_{TBO}$ = 25 µA to 0.2mA $T_J$ = 25 °C	-4.0		+0	%
V <sub>TBOclamp</sub>	Clamp voltage	<sup>(3)</sup> V <sub>VFF</sub> = 4 V	2.9	3	3.1	٧
I <sub>TBO_Pull</sub>	Pull-up current	V <sub>TBO</sub> = 1 V V <sub>FF</sub> = V <sub>MULT</sub> = 0 V			2	μА
PWM_STO	P		4			I
lleak	High level leakage current	V <sub>PWM_STOP</sub> = Vcc			1	μA
$V_{L}$	Low level	I <sub>PWM_STOP</sub> = 0.5 mA			1	V
RUN functi	on		1	u.	•	
I <sub>RUN</sub>	Input bias current	V <sub>RUN</sub> = 0 to 3 V			-1	μΑ
V <sub>DIS</sub>	Disable threshold	(3) voltage falling	0.745	0.8	0.855	V
V <sub>EN</sub>	Enable threshold	(3) voltage rising	0.845	0.88	0.915	٧
Start-up tin	mer	-	1			l
t <sub>START_DEL</sub>	Start-up delay	First cycle after wake-up	25	50	75	μs
	Time ou mouie d		75	150	300	
t <sub>START</sub>	Timer period	Restart after V <sub>CS</sub> > V <sub>CS_th</sub>	150	300	600	μs
Voltage fee	edforward		•			
V <sub>VFF</sub>	Linear operation range		0.8		3	٧
437		Vcc < Vcc <sub>On</sub>			800	
ΔV Dropout V <sub>MUL</sub>	Dropout V <sub>MULTpk</sub> -V <sub>VFF</sub>	Vcc > or = to Vcc <sub>On</sub>			20	mV
ΔV <sub>VFF</sub>	Line drop detection threshold	Below peak value	40	70	100	mV
ΔV <sub>VFF</sub>	Line drop detection threshold	Below peak value T <sub>J</sub> = 25 °C	50	70	90	mV
В	Internal discharge register	T <sub>J</sub> = 25 °C	7.5	10	12.5	kO
R <sub>DISCH</sub>	Internal discharge resistor		5		20	kΩ

Table 4. Electrical characteristics (continued)

Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit
V <sub>VFF</sub>	Linear operation range		0.8		3	V
PWM_LAT	СН		·			
lleak	Low level leakage current	V <sub>PWM_LATCH</sub> = 0			-1	μΑ
V <sub>H</sub>	High level	I <sub>PWM_LATCH</sub> = -0.5 mA	4.5			V
V <sub>H</sub>	High level	I <sub>PWM_LATCH</sub> = -0.25 mA Vcc = Vcc <sub>Off</sub>	2.5			٧
V <sub>H</sub>	High level	$I_{PWM\_LATCH} = -0.25 \text{ mA}$ $Vcc = Vcc_{Off} T_J = 25 ^{\circ}\text{C}$	2.8			٧
Gate drive	r					
V <sub>OL</sub>	Output low voltage	I <sub>sink</sub> = 100 mA		0.6	1.2	٧
V <sub>OH</sub>	Output high voltage	I <sub>source</sub> = 5 mA	9.8	10.3		V
I <sub>srcpk</sub>	Peak source current		-0.6			Α
I <sub>snkpk</sub>	Peak sink current		0.8			Α
t <sub>f</sub>	Voltage fall time			30	60	ns
t <sub>r</sub>	Voltage rise time			45	110	ns
V <sub>Oclamp</sub>	Output clamp voltage	I <sub>source</sub> = 5 mA; Vcc = 20 V	10	12	15	٧
	UVLO saturation	Vcc= 0 to V <sub>CCon</sub> , I <sub>sink</sub> = 2 mA			1.1	V

- 1. Parameters tracking each other
- 2. The multiplier output is given by:

$$V_{CS} = V_{CS\_Ofst} + K_M \cdot \frac{V_{MULT} \cdot \left(V_{COMP} - 2.5\right)}{V_{VFF}^2}$$

3. Parameters tracking each other

# 5 Typical electrical performance

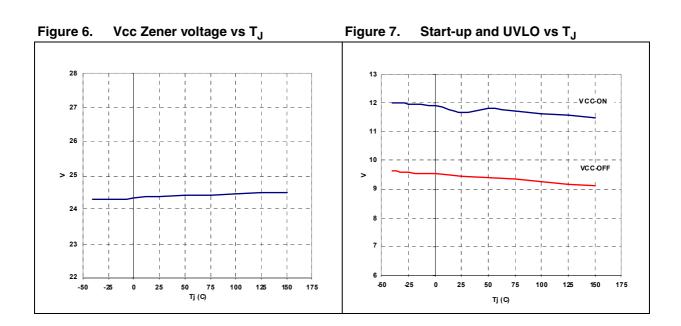
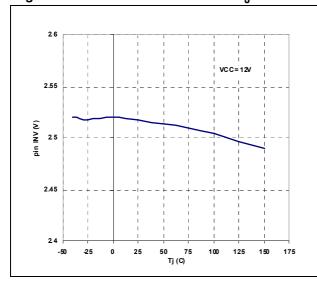


Figure 8. Feedback reference vs T<sub>J</sub>

Figure 9. E/A output clamp levels vs T<sub>J</sub>



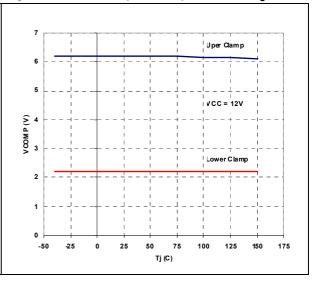
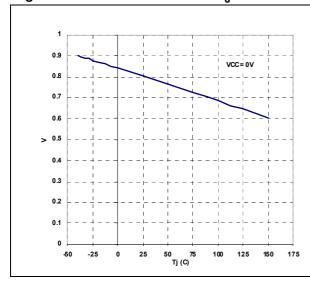


Figure 10. UVLO saturation vs T<sub>J</sub>

Figure 11. OVP levels vs T<sub>J</sub>



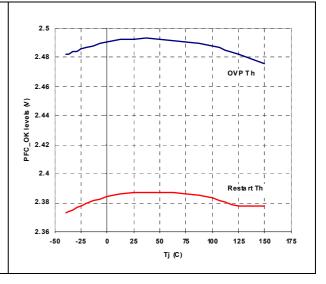


Figure 12. Inductor saturation threshold vs  $T_J$  Figure 13. Vcs clamp vs  $T_J$ 

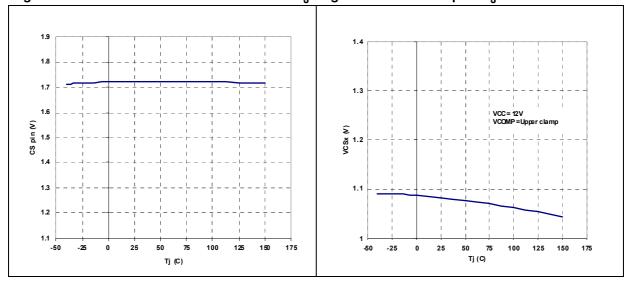


Figure 14. ZCD sink/source capability vs T<sub>J</sub> Figure 15. ZCD clamp level vs T<sub>J</sub>

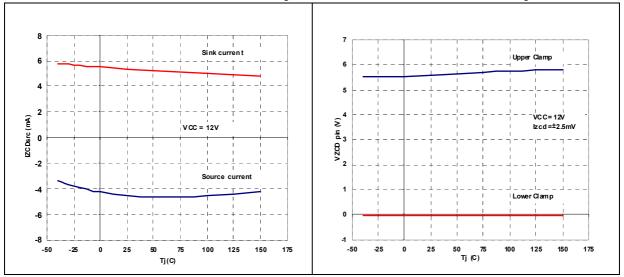


Figure 16. TBO clamp vs T<sub>J</sub>

Figure 17.  $V_{VFF}$  -  $V_{TBO}$  dropout vs  $T_J$ 

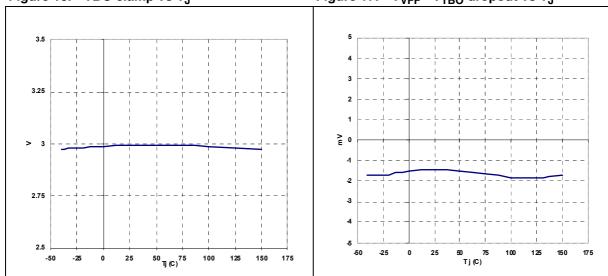


Figure 18.  $I_{INV}$  -  $I_{TBO}$  current mismatch vs  $T_J$  Figure 19.  $I_{INV}$  -  $I_{TBO}$  mismatch vs  $I_{TBO}$  current

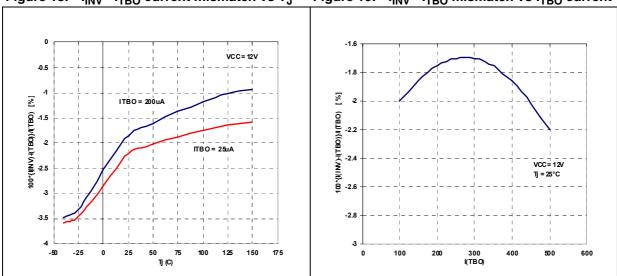


Figure 20. R discharge vs T<sub>J</sub>

Figure 21. Line drop detection threshold vs T<sub>J</sub>

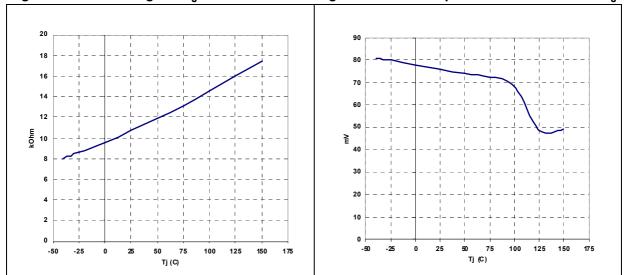


Figure 22.  $V_{MULTpk}$  -  $V_{VFF}$  dropout vs  $T_J$ 

Figure 23. PFC\_OK threshold vs T<sub>J</sub>

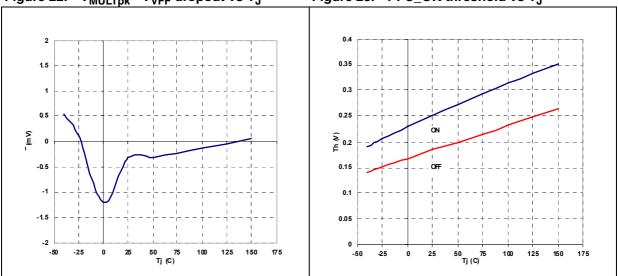
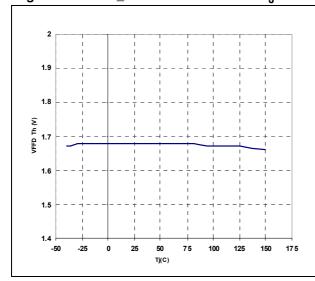


Figure 24. PFC\_OK FFD threshold vs T<sub>J</sub>

Figure 25. PWM\_LATCH high saturation vs T<sub>J</sub>



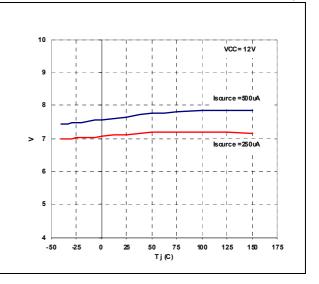
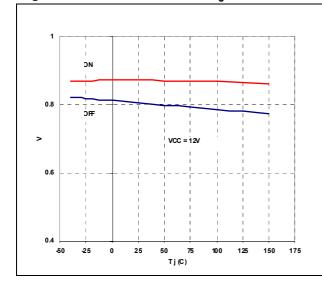


Figure 26. RUN threshold vs  $T_J$ 

Figure 27. PWM\_STOP low saturation vs T<sub>J</sub>



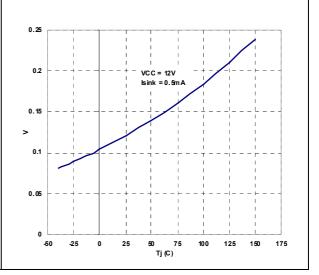
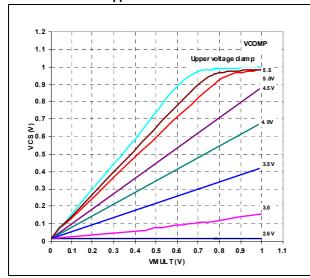


Figure 28. Multiplier characteristics @ V<sub>FF</sub> = 1 V

Figure 29. Multiplier characteristics  $@V_{FF} = 3 V$ 



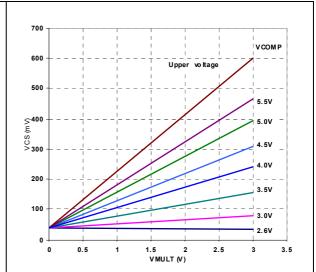
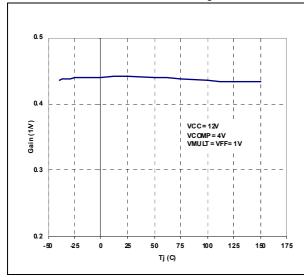


Figure 30. Multiplier gain vs T<sub>J</sub>

Figure 31. Gate drive clamp vs T<sub>J</sub>



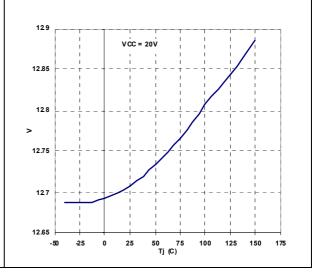


Figure 32. Gate drive output saturation vs  $T_J$  Figure 33. Delay to output vs  $T_J$ 

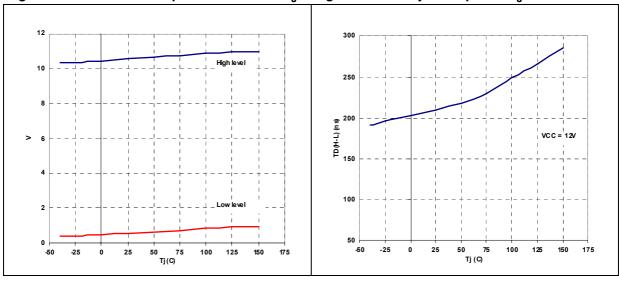
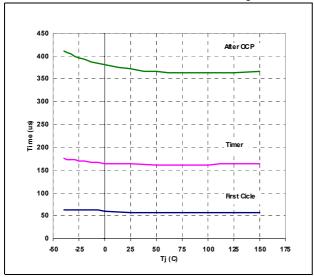


Figure 34. Start-up timer period vs T<sub>J</sub>



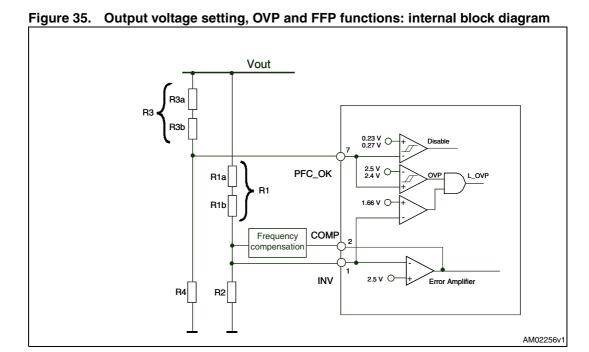
## 6 Application information

### 6.1 Overvoltage protection

Normally, the voltage control loop keeps the output voltage Vo of the PFC pre-regulator close to its nominal value, set by the ratio of the resistors R1 and R2 of the output divider. A pin of the device (PFC\_OK) has been dedicated to monitor the output voltage with a separate resistor divider (R3 high, R4 low, see *Figure 35*). This divider is selected so that the voltage at the pin reaches 2.5 V if the output voltage exceeds a preset value, usually larger than the maximum Vo that can be expected.

Example:  $V_O = 400 \text{ V}$ ,  $V_{OX} = 434 \text{ V}$ . Select:  $R3 = 8.8 \text{ M}\Omega$ ; then:  $R4 = 8.8 \text{ M}\Omega \cdot 2.5/(434-2.5) = 51 \text{ k}\Omega$ .

When this function is triggered, the gate drive activity is immediately stopped until the voltage on the pin PFC\_OK drops below 2.4 V. Notice that R1, R2, R3 and R4 can be selected without any constraints. The unique criterion is that both dividers have to sink a current from the output bus which needs to be significantly higher than the bias current of both INV and PFC\_OK pins.



### 6.2 Feedback failure protection (FFP)

The OVP function above described handles "normal" over voltage conditions, i.e. those resulting from an abrupt load/line change or occurring at start-up. In case the overvoltage is generated by a feedback disconnection, for instance when the upper resistor of the output divider (R1) fails open, an additional comparator detects the voltage at pin INV. If the voltage is lower than 1.66 V and the OVP is active, the FFP is triggered, the gate drive activity is immediately stopped, the device is shut down, its quiescent consumption is reduced below 180 µA and the condition is latched as long as the supply voltage of the IC is above the UVLO threshold. At the same time the pin PWM\_LATCH is asserted high. PWM\_LATCH is an open source output able to deliver 2.8 V minimum with 0.25 mA load, intended for tripping a latched shutdown function of the PWM controller IC in the cascaded dc-dc converter, so that the entire unit is latched off. To restart the system it is necessary to recycle the input power, so that the Vcc voltage of both the L6563S goes below 6V and that one of the PWM controller goes below its UVLO threshold.

The pin PFC\_OK doubles its function as a not-latched IC disable: a voltage below 0.23V will shut down the IC, reducing its consumption below 2 mA. In this case both PWM\_STOP and PWM\_LATCH keep their high impedance status. To restart the IC simply let the voltage at the pin go above 0.27 V.

Note that these functions offer a complete protection against not only feedback loop failures or erroneous settings, but also against a failure of the protection itself. Either resistor of the PFC\_OK divider failing short or open or a PFC\_OK pin floating will result in shutting down the IC and stopping the pre-regulator.

### 6.3 Voltage feedforward

The power stage gain of PFC pre-regulators varies with the square of the RMS input voltage. So does the crossover frequency fc of the overall open-loop gain because the gain has a single pole characteristic. This leads to large trade-offs in the design.

For example, setting the gain of the error amplifier to get fc = 20 Hz @ 264 Vac means having fc 4 Hz @ 88 Vac, resulting in a sluggish control dynamics. Additionally, the slow control loop causes large transient current flow during rapid line or load changes that are limited by the dynamics of the multiplier output. This limit is considered when selecting the sense resistor to let the full load power pass under minimum line voltage conditions, with some margin. But a fixed current limit allows excessive power input at high line, whereas a fixed power limit requires the current limit to vary inversely with the line voltage.

Voltage Feedforward can compensate for the gain variation with the line voltage and allow minimizing all of the above-mentioned issues. It consists of deriving a voltage proportional to the input RMS voltage, feeding this voltage into a squarer/divider circuit (1/V2 corrector) and providing the resulting signal to the multiplier that generates the current reference for the inner current control loop (see *Figure 36*).

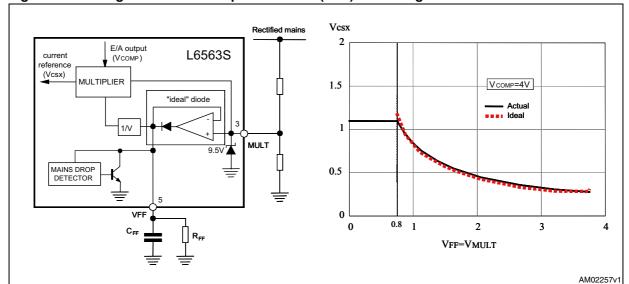


Figure 36. Voltage feedforward: squarer-divider (1/V2) block diagram and transfer characteristic

In this way a change of the line voltage will cause an inversely proportional change of the half sine amplitude at the output of the multiplier (if the line voltage doubles the amplitude of the multiplier output will be halved and vice versa) so that the current reference is adapted to the new operating conditions with (ideally) no need for invoking the slow dynamics of the error amplifier. Additionally, the loop gain will be constant throughout the input voltage range, which improves significantly dynamic behavior at low line and simplifies loop design.

Actually, deriving a voltage proportional to the RMS line voltage implies a form of integration, which has its own time constant. If it is too small the voltage generated will be affected by a considerable amount of ripple at twice the mains frequency that will cause distortion of the current reference (resulting in high THD and poor PF); if it is too large there will be a considerable delay in setting the right amount of feedforward, resulting in excessive overshoot and undershoot of the pre-regulator's output voltage in response to large line voltage changes. Clearly a trade-off was required.

The L6563S realizes a NEW voltage feed forward that, with a technique that makes use of just two external parts, strongly minimizes this time constant trade-off issue whichever voltage change occurs on the mains, both surges and drops. A capacitor  $C_{FF}$  and a resistor RFF, both connected from the pin VFF (#5) to ground, complete an internal peak-holding circuit that provides a DC voltage equal to the peak of the rectified sine wave applied on pin MULT (#3). In this way, in case of sudden line voltage rise,  $C_{FF}$  will be rapidly charged through the low impedance of the internal diode; in case of line voltage drop, an internal "mains drop" detector enables a low impedance switch which suddenly discharges CFF avoiding long settling time before reaching the new voltage level. The discharge of CFF is stopped as its voltage equals the voltage on pin MULT or if the voltage on pin RUN (in case it is connected to VFF) falls below 0.88 V, to prevent the "Brownout protection" function from being improperly activated (see "Section 6.7 on page 31).

As a result of the VFF pin functionality, an acceptably low steady-state ripple and low current distortion can be achieved with a limited undershoot or overshoot on the pre-regulator's output.

The twice-mains-frequency  $(2 \cdot f_L)$  ripple appearing across  $C_{FF}$  is triangular with a peak-to-peak amplitude that, with good approximation, is given by:

$$\Delta V_{FF} = \frac{2 V_{MULTpk}}{1 + 4 f_I R_{FF} C_{FF}}$$

where  $f_L$  is the line frequency. The amount of 3rd harmonic distortion introduced by this ripple, related to the amplitude of its  $2 \cdot f_L$  component, will be:

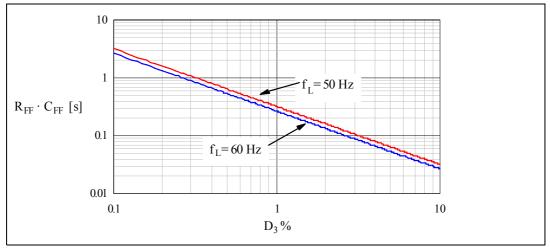
$$D_3\% = \frac{100}{2\pi\,f_L R_{FF} C_{FF}}$$

Figure 37 shows a diagram that helps choose the time constant  $R_{FF} \cdot C_{FF}$  based on the amount of maximum desired 3rd harmonic distortion. Note that there is a minimum value for the time constant  $R_{FF} \cdot C_{FF}$  below which improper activation of the VFF fast discharge may occur. In fact, the twice-mains-frequency ripple across CFF under steady state conditions must be lower than the minimum line drop detection threshold ( $V_{VFF\_min} = 40 \text{ mV}$ ). Therefore:

$$R_{FF} \cdot C_{FF} > \frac{2 \frac{V_{MULTpk\_max}}{\Delta V_{VFF\_min}} - 1}{4 \, f_{L\_min}}$$

Always connect  $R_{FF}$  and  $C_{FF}$  to the pin, the IC will not work properly if the pin is either left floating or connected directly to ground.

Figure 37. R<sub>FF</sub>·C<sub>FF</sub> as a function of 3rd harmonic distortion introduced in the input current



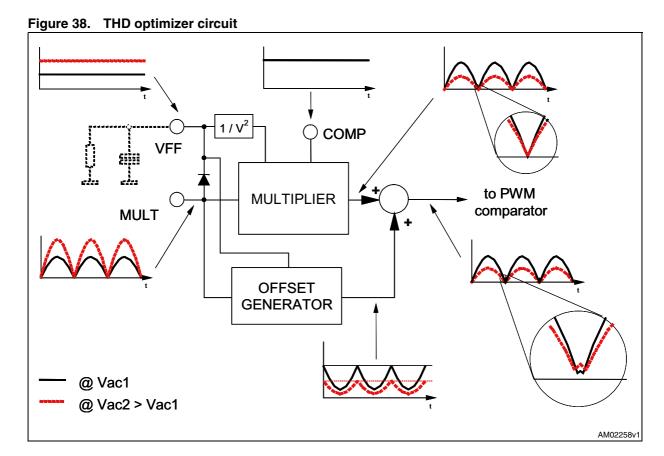
### 6.4 THD optimizer circuit

The L6563S is provided with a special circuit that reduces the conduction dead-angle occurring to the AC input current near the zero-crossings of the line voltage (crossover distortion). In this way the THD (total harmonic distortion) of the current is considerably reduced.

A major cause of this distortion is the inability of the system to transfer energy effectively when the instantaneous line voltage is very low. This effect is magnified by the high-frequency filter capacitor placed after the bridge rectifier, which retains some residual voltage that causes the diodes of the bridge rectifier to be reverse-biased and the input current flow to temporarily stop.

To overcome this issue the device forces the PFC pre-regulator to process more energy near the line voltage zero-crossings as compared to that commanded by the control loop. This will result in both minimizing the time interval where energy transfer is lacking and fully discharging the high-frequency filter capacitor after the bridge.

Figure 38 shows the internal block diagram of the THD optimizer circuit.



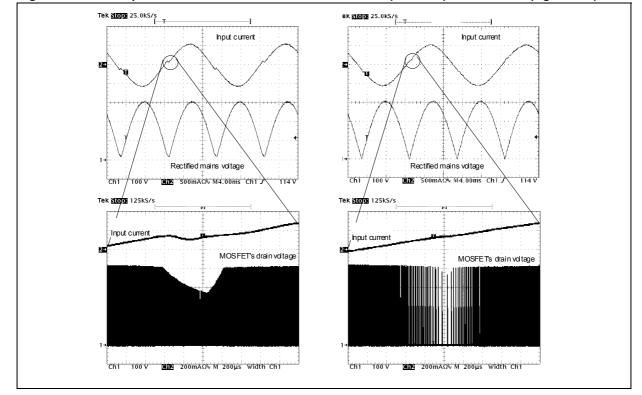


Figure 39. THD optimization: standard TM PFC controller (left side) and L6563S (right side)

Essentially, the circuit artificially increases the ON-time of the power switch with a positive offset added to the output of the multiplier in the proximity of the line voltage zero-crossings. This offset is reduced as the instantaneous line voltage increases, so that it becomes negligible as the line voltage moves toward the top of the sinusoid. Furthermore the offset is modulated by the voltage on the VFF pin (see "Voltage Feedforward" section) so as to have little offset at low line, where energy transfer at zero crossings is typically quite good, and a larger offset at high line where the energy transfer gets worse.

The effect of the circuit is shown in *Figure 39*, where the key waveforms of a standard TM PFC controller are compared to those of this chip.

To take maximum benefit from the THD optimizer circuit, the high-frequency filter capacitor after the bridge rectifier should be minimized, compatibly with EMI filtering needs. A large capacitance, in fact, introduces a conduction dead-angle of the AC input current in itself - even with an ideal energy transfer by the PFC pre-regulator - thus reducing the effectiveness of the optimizer circuit.

# 6.5 Tracking boost function

In some applications it may be advantageous to regulate the output voltage of the PFC preregulator so that it tracks the RMS input voltage rather than at a fixed value like in conventional boost pre-regulators. This is commonly referred to as "tracking boost" or "follower boost" approach.

With the L6563S this can be realized by connecting a resistor (RT) between the TBO pin and ground. The TBO pin presents a DC level equal to the peak of the MULT pin voltage and is then representative of the mains RMS voltage. The resistor defines a current, equal to

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V(TBO)/RT, that is internally 1:1 mirrored and sunk from pin INV (#1) input of the L6563S's error amplifier. In this way, when the mains voltage increases the voltage at TBO pin will increase as well and so will do the current flowing through the resistor connected between TBO and GND. Then a larger current will be sunk by INV pin and the output voltage of the PFC pre-regulator will be forced to get higher. Obviously, the output voltage will move in the opposite direction if the input voltage decreases.

To avoid undesired output voltage rise should the mains voltage exceed the maximum specified value, the voltage at the TBO pin is clamped at 3V. By properly selecting the multiplier bias it is possible to set the maximum input voltage above which input-to-output tracking ends and the output voltage becomes constant. If this function is not used, leave the pin open: the device will regulate a fixed output voltage.

Starting from the following data:

- Vin<sub>1</sub> = minimum specified input RMS voltage;
- Vin<sub>2</sub> = maximum specified input RMS voltage;
- Vo<sub>1</sub> = regulated output voltage @ Vin = Vin<sub>1</sub>;
- Vo<sub>2</sub> = regulated output voltage @ Vin = Vin<sub>2</sub>;
- Vox = absolute maximum limit for the regulated output voltage;

to set the output voltage at the desired values use the following design procedure:

Determine the input RMS voltage Vinclamp that produces Vo = Vox:

$$Vin_{clamp} = \frac{Vox - Vo_1}{Vo_2 - Vo_1} \cdot Vin_2 - \frac{Vox - Vo_2}{Vo_2 - Vo_1} \cdot Vin_1$$

and choose a value  $Vin_x$  such that  $Vin_2 \le Vinx < Vinclamp$ . This will result in a limitation of the output voltage range below Vox (it will equal Vox if one chooses  $Vin_x = Vin_{clamp}$ )

2. Determine the divider ratio of the MULT pin (#3) bias:

$$k = \frac{3}{\sqrt{2} \cdot \text{Vin}_x}$$

and check that at minimum mains voltage Vin1 the peak voltage on pin 3 is greater than 0.65 V.

- 3. Determine R1, the upper resistor of the output divider, for instance 3 M $\Omega$ .
- 4. Calculate the lower resistor R2 of the output divider and the adjustment resistor RT:

$$\begin{cases} R2 = 2.5 \cdot R1 \cdot \frac{Vin_2 - Vin_1}{\left(Vo_1 - 2.5\right) \cdot Vin_2 - \left(Vo_2 - 2.5\right) \cdot Vin_1} \\ R_T = \sqrt{2} \cdot k \cdot R1 \cdot \frac{Vin_2 - Vin_1}{Vo_2 - Vo_1} \end{cases}$$

Check that the maximum current sourced by the TBO pin (#6) does not exceed the maximum specified (0.2 mA):

$$I_{TBO\,max} = \frac{3}{R_T} \le 0.2 \cdot 10^{-3}$$

Figure 40 shows the internal block diagram of the tracking boost function.

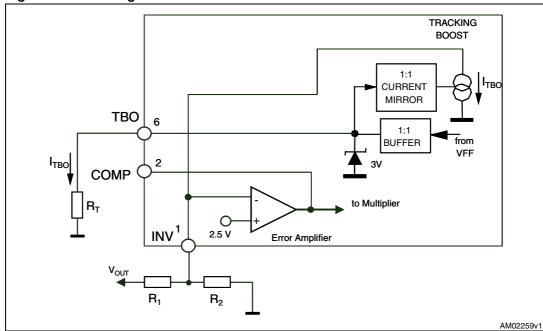
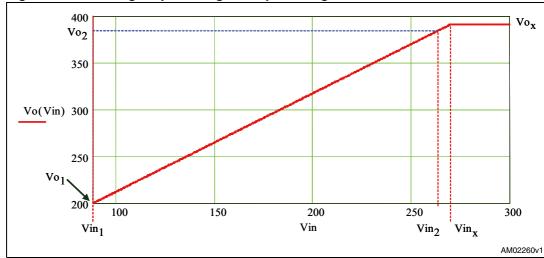


Figure 40. Tracking boost block





### 6.6 Inductor saturation detection

Boost inductor's hard saturation may be a fatal event for a PFC pre-regulator: the current upslope becomes so large (50-100 times steeper, see *Figure 42*) that during the current sense propagation delay the current may reach abnormally high values. The voltage drop caused by this abnormal current on the sense resistor reduces the gate-to-source voltage, so that the MOSFET may work in the active region and dissipate a huge amount of power, which leads to a catastrophic failure after few switching cycles.

However, in some applications such as ac-dc adapters, where the PFC pre-regulator is turned off at light load for energy saving reasons, even a well-designed boost inductor may

occasionally slightly saturate when the PFC stage is restarted because of a larger load demand. This happens when the restart occurs at an unfavorable line voltage phase, i.e. when the output voltage is significantly below the rectified peak voltage. As a result, in the boost inductor the inrush current coming from the bridge rectifier adds up to the switched current and, furthermore, there is little or no voltage available for demagnetization.

To cope with a saturated inductor, the L6563S is provided with a second comparator on the current sense pin (CS, pin 4) that stops the IC if the voltage, normally limited within 1.1 V, exceeds 1.7 V. After that, the IC will be attempted to restart by the internal starter circuitry; the starter repetition time is twice the nominal value to guarantee lower stress for the inductor and boost diode. Hence, the system safety will be considerably increased.

Vcs Vcs Vcs  $\Delta IL$ 1.7V -1.7V 1.7V ₫ ΔIL Multiplier Multiplier Multiplier Output Output Output t Tdelay Tdelay Tdelay Inductor not saturating Inductor slightly saturating Inductor saturating hard

Figure 42. Effect of boost inductor saturation on the MOSFET current and detection method

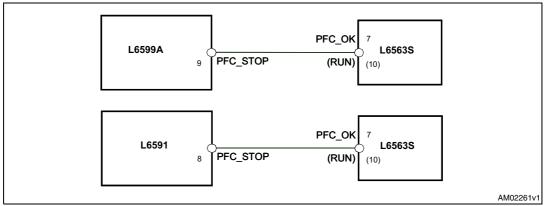
### 6.7 Power management/housekeeping functions

A special feature of this IC is that it facilitates the implementation of the "housekeeping" circuitry needed to co-ordinate the operation of the PFC stage to that of the cascaded DC-DC converter. The functions realized by the housekeeping circuitry ensure that transient conditions like power-up or power down sequencing or failures of either power stage be properly handled.

This device provides some pins to do that. One communication line between the IC and the PWM controller of the cascaded dc-dc converter is the pin PWM\_LATCH (*Figure 44*b), which is normally open (high impedance) when the PFC works properly, and goes high if it loses control of the output voltage (because of a feedback loop disconnection) with the aim of latching off the PWM controller of the cascaded dc-dc converter as well (see "Feedback failure protection" section for more details).

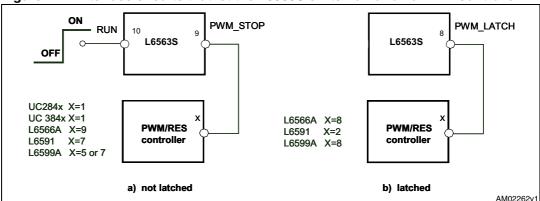
A second communication line can be established via the disable function included in the PFC\_OK pin (see "Feedback failure protection" section for more details). Typically this line is used to allow the PWM controller of the cascaded dc-dc converter to drive in burst mode operation the L6563S in case of light load and to minimize the no-load input consumption. Interface circuits like those are shown in *Figure 43*.

Figure 43. Interface circuits that let dc-dc converter's controller IC drive L6563S in burst mode



The third communication line is the pin PWM\_STOP (#9), which works in conjunction with the pin RUN (#10). The purpose of the PWM\_STOP pin is to inhibit the PWM activity of both the PFC stage and the cascaded dc-dc converter. The pin is an open collector, normally open, that goes low if the device is disabled by a voltage lower than 0.8 V on the RUN pin. The pin goes again open if the voltage on pin RUN exceeds 0.88V. It is important to point out that this function works correctly in systems where the PFC stage is the master and the cascaded dc-dc converter is the slave or, in other words, where the PFC stage starts first, powers both controllers and enables/disables the operation of the dc-dc stage. The pin RUN can be used to start and stop the main converter. In the simplest case, to enable/disable the PWM controller the pin PWM\_STOP can be connected to the output of the error amplifier (Figure 44a).

Figure 44. Interface circuits that let the L6563S switch on or off a PWM controller



If the chip is provided with a soft-start pin, it is possible to delay the start-up of the dc-dc stage with respect to that of the PFC stage, which is often desired, as described in *Figure 45*. An underlying assumption in order for that to work properly is that the UVLO thresholds of the PWM controller are certainly higher than those of the L6563S.

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ON RUN 10 L6563S 9 PWM\_STOP

L6566A X=14
L6591 X=4
L6599A X=1

PWM/RES controller

C<sub>SS</sub>

Figure 45. Interface circuits for power up sequencing when dc-dc has the SS function

If this is not the case or it is not possible to achieve a start-up delay long enough (because this prevents the dc-dc stage from starting up correctly) or, simply, the PWM controller is devoid of soft start, the arrangement of *Figure 46* lets the dc-dc converter start-up when the voltage generated by the PFC stage reaches a preset value. The technique relies on the UVLO thresholds of the PWM controller.

HV bus Supply rail BC337 L5991/A: X=8+9 UC284x: X=7 UC384x: X=7 10  $k\Omega$ I 6565 X=8 L6598: X=12 PWM STOP BC558C ٧Z 14 **PWM** RUN 10 L6563S controller '욧 Vcc Off < VZ < Vccmax AM02264v

Figure 46. Interface circuits for actual power-up sequencing (master PFC)

Another possible use of the RUN and PWM\_STOP pins (again, in systems where the PFC stage is the master) is the brownout protection, thanks to the hysteresis provided.

The brownout protection is basically a not-latched device shutdown function that is activated when a condition of mains undervoltage is detected. This condition may cause overheating of the primary power section due to an excess of RMS current. Brownout can also cause the PFC pre-regulator to work open loop and this could be dangerous to the PFC stage itself and the downstream converter, should the input voltage return abruptly to its rated value. Another problem is the spurious restarts that may occur during converter power down and that cause the output voltage of the converter not to decay to zero monotonically. For these reasons it is usually preferable to shutdown the unit in case of brownout.

IC shutdown upon brownout can be easily realized as shown in Figure 47. The scheme on the left is of general use, that one on the right can be used if the bias levels of the multiplier and the  $R_{FF}$ - $C_{FF}$  time constant are compatible with the specified brownout level and with the specified holdup time respectively. In this latest case, an additional resistor voltage divider and one capacitor are not needed.

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In table 1 it is possible to find a summary of all of the above mentioned working conditions that cause the device to stop operating.

Figure 47. Brownout protection (master PFC)

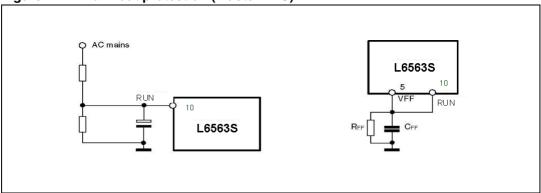


Table 5. Summary of L6563S idle states

Condition	Caused or revealed bey	IC behavior	Restart condition	Typical IC consumption	PWM_LATCH Status	PWM_STOP Status
UVLO	Vcc < Vcc <sub>Off</sub>	Disabled	Vcc > Vcc <sub>On</sub>	90 μΑ	Off	High
Feedback disconnected	PFC_OK > V <sub>PFC_OK_S</sub> AND INV < 1.66V	Latched	Vcc < Vcc <sub>restart</sub> then Vcc > Vcc <sub>On</sub>	180 μΑ	High	High
Standby	PFC_OK < V <sub>PFC_OK_D</sub>		PFC_OK > V <sub>PFC_OK_E</sub>	1.5 mA	Off	High
AC brownout	RUN < V <sub>DIS</sub>	Stop switching	RUN > V <sub>EN</sub>	1.5 mA	Off	Low
OVP	PFC_OK > V <sub>PFC_OK_S</sub>	3	PFC_OK < V <sub>PFC_OK_R</sub>	2.2 mA	Off	High
Low consumption	COMP < 2.4V	Burst mode	COMP > 2.4V	2.2 mA	Off	High
Saturated boost inductor	Vcs > V <sub>CS_th</sub>	Doubled Tstart	Auto restart	2.2 mA	Off	High

# 7 Application examples and ideas

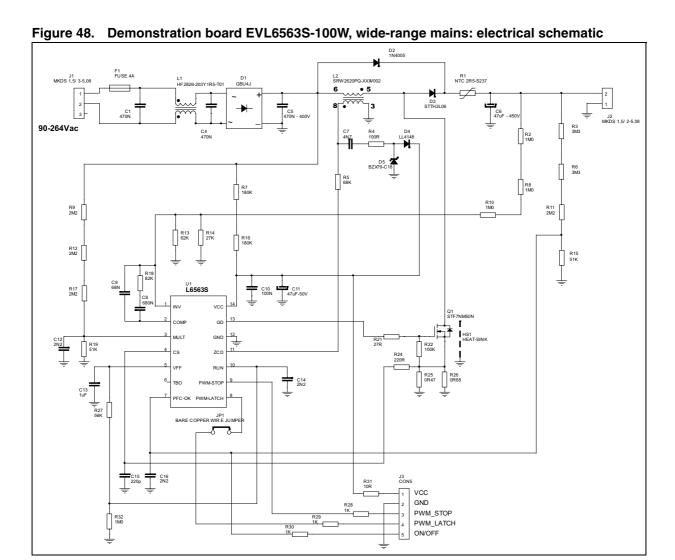


Figure 49. L6563S 100 W TM PFC demonstration board: compliance to EN61000-3-2 standard

Figure 50. L6563S 100 W TM PFC demonstration board: compliance to JEITA-MITI standard

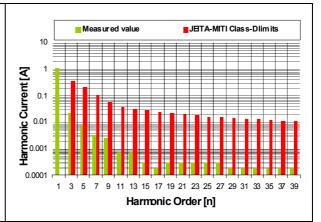
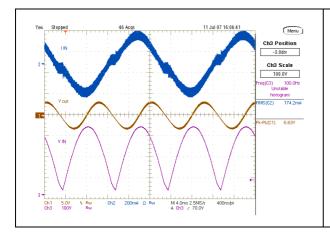
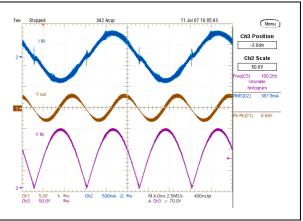


Figure 51. L6563S 100 W TM PFC demonstration board: input current waveform @230-50 Hz - 100 W load

Figure 52. L6563S 100W TM PFC demonstration board: input current waveform @100 V-50 Hz - 100 W load





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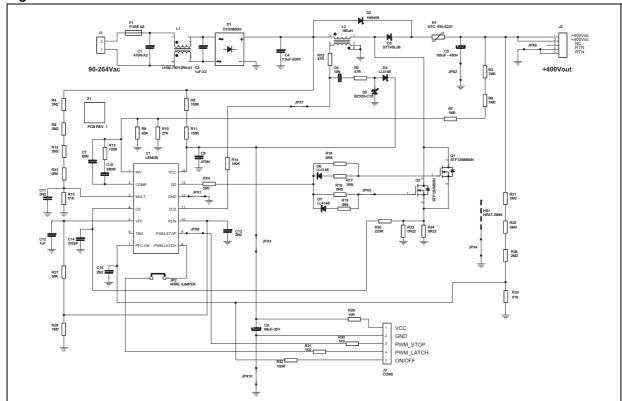
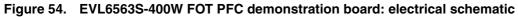
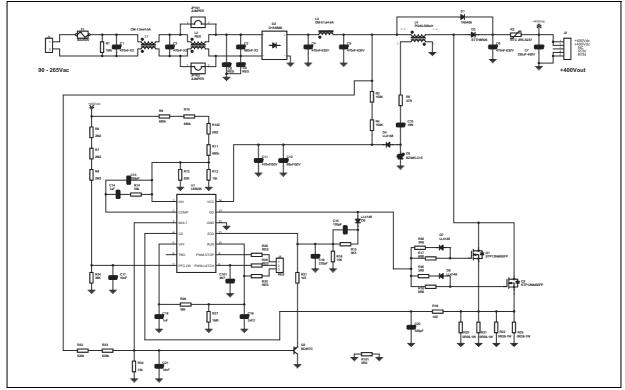


Figure 53. EVL6563S-250W TM PFC demonstration board: electrical schematic





CNZ R19 2N2 R20 188 % R22 R15 R16 80k R18 23 K 1 F & 7 D2 STTH8006 10 A 4 8 5 6 8 Zoz **¥**8₹ 8 § R24 R24 R24 R12 220R CS Pur-25v U1 L6563S 330pF 羟氧 8\$ 05 \$2 \$4 R23 R9 56k 330pF \$ \$ \$2 ₹ ₹8 ₹ 2 € F1 HT 6.3A 280V 90-264Vac CN1 MKDS 1,5/3-5.08

Figure 55. EVL6563S-ZRC200W 200W PFC pre-regulator with ripple-free input current: electrical schematic

**577** 

# 8 Package mechanical data

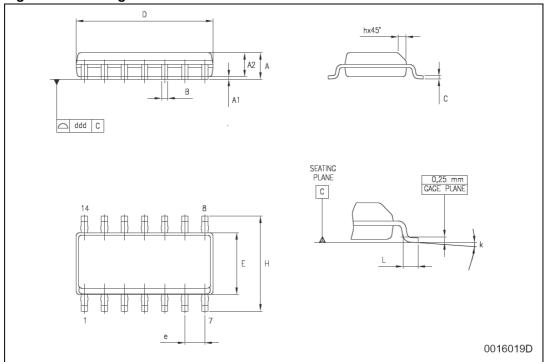
In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

Table 6. SO14 mechanical data

Dim.	mm.			
Dilli.	Min	Тур	Max	
А	1.350		1.750	
A1	0.100		0.250	
A2	1.100		1.650	
В	0.330		0.510	
С	0.190		0.250	
D	8.550		8.750	
E	3.800		4.000	
е		1.270		
Н	5.800		6.200	
h	0.250		0.500	
L	0.400		1.270	
k	0d		8d	
ddd			0.100	

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Figure 56. Package dimensions



L6563S Ordering codes

# 9 Ordering codes

Table 7. Ordering information

Order codes	Package	Packing
L6563S	SO14	Tube
L6563STR	SO14	Tape and reel

Revision history L6563S

# 10 Revision history

Table 8. Document revision history

Date	Revision	Changes
12-Aug-2009	1	Initial release.
03-Sep-2009	2	Updated mechanical data.
29-Jan-2010	3	Updated Table 4 on page 11.
02-Aug-2010	4	Updated Figure 1 on page 1, Figure 4 on page 15, Table 3 on page 8, Table 4 on page 11 and Section 6.2 on page 24.

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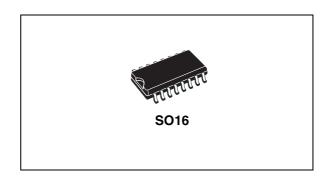




### High voltage start-up transition-mode PFC

#### **Features**

- On-board 700 V start-up source
- Tracking boost function
- Fast "bidirectional" input voltage feedforward (1/V2 correction)
- Interface for cascaded converter's PWM controller
- Remote ON/OFF control
- Accurate adjustable output overvoltage protection
- Protection against feedback loop disconnection (latched shutdown)
- Inductor saturation protection
- Low (≤ 100 µA) start-up current
- 6 mA max. operating bias current
- 1% (@  $T_J = 25$  °C) internal reference voltage
- -600/+800 mA totem pole gate driver with active pull-down during UVLO



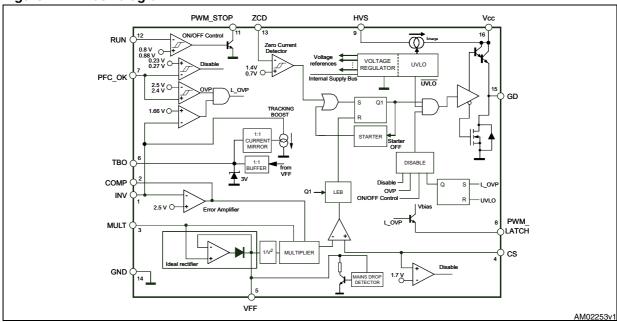
### **Applications**

PFC pre-regulators for:

- Hi-end AC-DC adapter/charger
- IEC61000-3-2 or JEITA-MITI compliant SMPS, in excess of 400 W

SMPS for LED luminaires





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Description L6563H

### 1 Description

The L6563H is a current-mode PFC controller operating in transition mode (TM) which embeds the same features existing in the L6563S with the addition of a high voltage start-up source. These functions make the IC especially suitable for applications that have to be compliant with energy saving regulations and where the PFC pre-regulator works as the master stage.

The highly linear multiplier, along with a special correction circuit that reduces crossover distortion of the mains current, allows wide-range-mains operation with an extremely low THD even over a large load range.

The output voltage is controlled by means of a voltage-mode error amplifier and an accurate (1% @Tj = 25 °C) internal voltage reference. Loop's stability is optimized by the voltage feedforward function (1/ $V^2$  correction), which in this IC uses a proprietary technique that considerably improves line transient response as well in case of mains both drops and surges ("bidirectional").

Additionally, the IC provides the option for tracking boost operation, i.e. the output voltage is changed tracking the mains voltage.

The device includes disable functions suitable for remote ON/OFF control too.

In addition to an over voltage protection able to keep the output voltage under control during transient conditions, the IC is provided also with a protection against feedback loop failures or erroneous settings. Other on-board protection functions allow that brownout conditions and boost inductor saturation can be safely handled.

An interface with the PWM controller of the DC-DC converter supplied by the PFC preregulator is provided: the purpose is to stop the operation of the converter in case of anomalous conditions for the PFC stage (feedback loop failure, boost inductor's core saturation, etc.) and to handle the PFC stage in case of light load for the DC-DC converter, to make it easier to comply with energy saving regulations (Blue Angel, EnergyStar, Energy2000, etc.).

The totem-pole output stage, capable of 600 mA source and 800 mA sink current, is suitable for big MOSFET or IGBT drive. This, combined with the other features and the possibility to operate with ST's proprietary fixed-off-time control, makes the device an excellent solution for SMPS up to 400 W that need to be compliant with EN61000-3-2 and JEITA-MITI standards.

L6563H Maximum ratings

# 2 Maximum ratings

## 2.1 Absolute maximum ratings

Table 1. Absolute maximum ratings

Symbol	Pin	Parameter	Value	Unit
V <sub>HVS</sub>	9	Voltage range (referred to ground)	-0.3 to 700	V
I <sub>HVS</sub>	9	Output current	Self-limited	I <sub>HVS</sub>
Vcc	16	IC supply voltage (Icc = 20 mA)	self-limited	٧
	1, 3, 7	Max. pin voltage (I <sub>pin</sub> =1 mA)	Self-limited	٧
	2, 4 to 6, 8, 11, 12	Analog inputs and outputs	-0.3 to 8	٧
I <sub>PWM_STOP</sub>	11	Max. sink current	3	mA
I <sub>ZCD</sub>	13	Zero current detector max. current	-10 (source) 10 (sink)	mA

### 2.2 Thermal data

Table 2. Thermal data

Symbol	Parameter	Value	Unit
R <sub>thJA</sub>	Max. thermal resistance, junction-to-ambient	120	°C/W
Ptot	Power dissipation @T <sub>A</sub> = 50 °C	0.75	W
TJ	Junction temperature operating range	-40 to 150	°C
T <sub>stg</sub>	Storage temperature	-55 to 150	°C

Pin connection L6563H

### 3 Pin connection

Figure 2. Pin connection

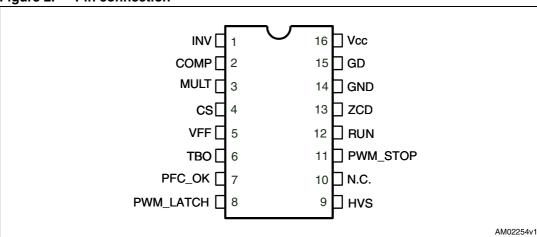


Table 3. Pin description

n°	Name	Function
1	INV	Inverting input of the error amplifier. The information on the output voltage of the PFC pre- regulator is fed into the pin through a resistor divider.  The pin normally features high impedance but, if the tracking boost function is used, an internal current generator programmed by TBO (pin 6) is activated. It sinks current from the pin to change the output voltage so that it tracks the mains voltage.
2	СОМР	Output of the error amplifier. A compensation network is placed between this pin and INV (pin 1) to achieve stability of the voltage control loop and ensure high power factor and low THD. To avoid uncontrolled rise of the output voltage at zero load, when the voltage on the pin falls below 2.4 V the gate driver output is inhibited (burst-mode operation).
3	MULT	Mains input to the multiplier. This pin is connected to the rectified mains voltage via a resistor divider and provides the sinusoidal reference to the current loop. The voltage on this pin is used also to derive the information on the RMS mains voltage.
4	CS	Input to the PWM comparator. The current flowing in the MOSFET is sensed through a resistor, the resulting voltage is applied to this pin and compared with an internal reference to determine MOSFET's turn-off.  A second comparison level at 1.7 V detects abnormal currents (e.g. due to boost inductor saturation) and, on this occurrence, activates a safety procedure that temporarily stops the converter and limits the stress of the power components.
5	VFF	Second input to the multiplier for $1/V^2$ function. A capacitor and a parallel resistor must be connected from the pin to GND. They complete the internal peak-holding circuit that derives the information on the RMS mains voltage. The voltage at this pin, a dc level equal to the peak voltage on pin MULT (3), compensates the control loop gain dependence on the mains voltage. Never connect the pin directly to GND but with a resistor ranging from 100 k $\Omega$ (minimum) to 2 M $\Omega$ (maximum).
6	ТВО	Tracking boost function. This pin provides a buffered VFF voltage. A resistor connected between this pin and GND defines a current that is sunk from pin INV (1). In this way, the output voltage is changed proportionally to the mains voltage (tracking boost). If this function is not used leave this pin open.

L6563H Pin connection

Table 3. Pin description (continued)

n°	Name	Function
7	PFC_OK	PFC pre-regulator output voltage monitoring/disable function. This pin senses the output voltage of the PFC pre-regulator through a resistor divider and is used for protection purposes. If the voltage on the pin exceeds 2.5 V the IC stops switching and restarts as the voltage on the pin falls below 2.4 V. However, if at the same time the voltage of the INV pin falls below 1.66V, a feedback failure is assumed. In this case the device is latched off and the PWM_LATCH (8) pin is asserted high. Normal operation can be resumed only by cycling Vcc bringing its value lower than 6V before to move up to Turn on threshold.  If the voltage on this pin is brought below 0.23 V the IC is shut down. To restart the IC the voltage on the pin must go above 0.27 V. This can be used as a remote on/off control input.
8	PWM_LATCH	Output pin for fault signaling. During normal operation this pin features high impedance. If a feedback failure is detected (PFC_OK > 2.5 V & INV < 1.66V) the pin is asserted high. Normally, this pin is used to stop the operation of the dc-dc converter supplied by the PFC preregulator by invoking a latched disable of its PWM controller. If not used, the pin is left floating.
9	HVS	High-voltage start-up. The pin, able to withstand 700 V, is to be tied directly to the rectified mains voltage. A 1 mA internal current source charges the capacitor connected between pin Vcc (16) and pin GND (14) until the voltage on the pin Vcc reaches the start-up threshold, then it is shut down. Normally, the generator is re-enabled when the Vcc voltage falls below 6 V to ensure a low power throughput during short circuit. Otherwise, when a latched protection is tripped the generator is re-enabled as Vcc reaches the UVLO threshold to keep the latch supplied.
10	N.C.	Not internally connected. Provision for clearance on the PCB to meet safety requirements.
11	PWM_STOP	Output pin for fault signaling. During normal operation this pin features high impedance. If the IC is disabled by a voltage below 0.8 V on pin RUN (12) the voltage on the pin is pulled to ground. Normally, this pin is used to temporarily stop the operation of the dc-dc converter supplied by the PFC pre-regulator by disabling its PWM controller. A typical usage of this function is brownout protection in systems where the PFC pre-regulator is the master stage. If not used, the pin is left floating.
12	RUN	Remote ON/OFF control. A voltage below 0.8 V shuts down (not latched) the IC and brings its consumption to a considerably lower level. PWM_STOP is asserted low. The IC restarts as the voltage at the pin goes above 0.88V. Connect this pin to pin VFF (5) either directly or through a resistor divider to use this function as brownout (AC mains undervoltage) protection.
13	ZCD	Boost inductor's demagnetization sensing input for transition-mode operation. A negative-going edge triggers MOSFET's turn-on.
14	GND	Ground. Current return for both the signal part of the IC and the gate driver.
15	GD	Gate driver output. The totem pole output stage is able to drive power MOSFET's and IGBT's with a peak current of 600 mA source and 800 mA sink. The high-level voltage of this pin is clamped at about 12 V to avoid excessive gate voltages.
16	Vcc	Supply voltage of both the signal part of the IC and the gate driver. Sometimes a small bypass capacitor (0.1 $\mu$ F typ.) to GND might be useful to get a clean bias voltage for the signal part of the IC.

Pin connection L6563H

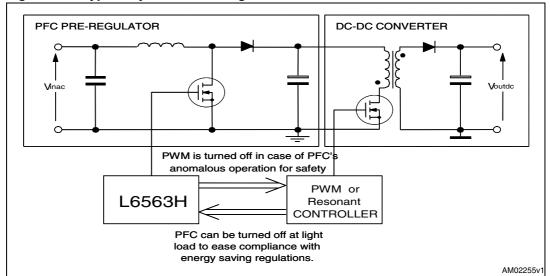


Figure 3. Typical system block diagram

### 4 Electrical characteristics

 $T_J$  = -25 to 125 °C,  $V_{CC}$  = 12 V,  $C_O$  = 1 nF between pin GD and GND,  $C_{FF}$  = 1  $\mu F$  and  $R_{FF}$  = 1  $M\Omega$  between pin VFF and GND; unless otherwise specified

Table 4. Electrical characteristics

Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit
Supply vol	tage		·			
Vcc	Operating range	After turn-on	10.3		22.5	V
Vcc <sub>On</sub>	Turn-on threshold	(1)	11	12	13	V
Vcc <sub>Off</sub>	Turn-off threshold	(1)	8.7	9.5	10.3	V
Vcc <sub>restart</sub>	Vcc for resuming from latch	OVP latched	5	6	7	V
Hys	Hysteresis		2.3		2.7	V
V <sub>Z</sub>	Zener voltage	Icc = 20 mA	22.5	25	28	V
Supply cur	rent		·			
I <sub>start-up</sub>	Start-up current	Before turn-on, Vcc = 10 V		90	150	μΑ
Iq	Quiescent current	After turn-on, V <sub>MULT</sub> = 1 V		4	5	mA
I <sub>CC</sub>	Operating supply current	@ 70 kHz		5	6.0	mA
ı	Idle state quiescent current	V <sub>PFC_OK</sub> > V <sub>PFC_OK_S</sub> AND V <sub>INV</sub> < V <sub>PFC_OK</sub> - V <sub>FFD</sub>		180	280	μΑ
I <sub>qdis</sub>		V <sub>PFC_OK</sub> < V <sub>PFC_OK_D</sub> OR V <sub>RUN</sub> < V <sub>DIS</sub>		1.5	2.2	mA
Iq	Quiescent current	V <sub>PFC_OK</sub> > V <sub>PFC_OK_S</sub> OR V <sub>COMP</sub> < 2.3 V		2.2	3	mA
High-voltag	ge start-up generator					
V <sub>HV</sub>	Breakdown voltage	I <sub>HV</sub> < 100 μA	700			V
V <sub>HVstart</sub>	Start voltage	I <sub>Vcc</sub> < 100 μA	65	80	100	V
I <sub>charge</sub>	Vcc charge current	V <sub>HV</sub> > V <sub>Hvstart</sub> , Vcc > 3 V	0.55	0.85	1	mA
	ON state current	V <sub>HV</sub> > V <sub>Hvstart</sub> , Vcc > 3 V		1.6	^	
I <sub>HV, ON</sub>	ON-state current	V <sub>HV</sub> > V <sub>Hvstart</sub> , Vcc = 0			0.8	mA
I <sub>HV, OFF</sub>	OFF-state leakage current	V <sub>HV</sub> = 400 V			40	μΑ
V	Voo rootort voltage	Vcc falling	5	6	7	V
V <sub>CCrestart</sub>	Vcc restart voltage	IC latched off <sup>(1)</sup>	8.7	9.5	10.3	_ v
Multiplier i	nput					
I <sub>MULT</sub>	Input bias current	V <sub>MULT</sub> = 0 to 3 V		-0.2	-1	μΑ
V <sub>MULT</sub>	Linear operation range		0 to 3			V
V <sub>CLAMP</sub>	Internal clamp level	I <sub>MULT</sub> = 1 mA	9	9.5		V

Electrical characteristics L6563H

Table 4. Electrical characteristics (continued)

Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit
ΔVcs ΔV <sub>MULT</sub>	Output max. slope	V <sub>MULT</sub> =0 to 0.4 V, V <sub>VFF</sub> = 0.8 V V <sub>COMP</sub> = Upper clamp	2.2	2.34		V/V
K <sub>M</sub>	Gain (2)	V <sub>MULT</sub> = 1 V, V <sub>COMP</sub> = 4 V	0.375	0.45	0.525	1/V
Error ampl	ifier	•	•	•	•	
V <sub>INV</sub>		T <sub>J</sub> = 25 °C	2.475	2.5	2.525	W
	Voltage feedback input threshold	10.3 V < Vcc < 22.5 V <sup>(3)</sup>	2.455		2.545	V
	Line regulation	Vcc = 10.3 V to 22.5 V		2	5	mV
I <sub>INV</sub>	Input bias current	TBO open, V <sub>INV</sub> = 0 to 4 V		-0.2	-1	μΑ
V <sub>INVCLAMP</sub>	Internal clamp level	I <sub>INV</sub> = 1 mA	8	9		٧
Gv	Voltage gain	Open loop	60	80		dB
GB	Gain-bandwidth product			1		MHz
	Source current	V <sub>COMP</sub> = 4 V, V <sub>INV</sub> = 2.4 V	2	4		mA
I <sub>COMP</sub>	Sink current	V <sub>COMP</sub> = 4 V, V <sub>INV</sub> = 2.6 V	2.5	4.5		mA
	Upper clamp voltage	I <sub>SOURCE</sub> = 0.5 mA	5.7	6.2	6.7	
$V_{COMP}$	Burst-mode voltage	(3)	2.3	2.4	2.5	V
	Lower clamp voltage	I <sub>SINK</sub> = 0.5 mA <sup>(3)</sup>	2.1	2.25	2.4	
Current se	nse comparator	•	•	•	•	
I <sub>CS</sub>	Input bias current	V <sub>CS</sub> = 0			1	μΑ
t <sub>LEB</sub>	Leading edge blanking		100	150	250	ns
td <sub>(H-L)</sub>	Delay to output		100	200	300	ns
V <sub>CSclamp</sub>	Current sense reference clamp	V <sub>COMP</sub> = Upper clamp, V <sub>MULT</sub> =1 V V <sub>VFF</sub> = 1 V	1.0	1.08	1.16	٧
Voc	Current sense offset	V <sub>MULT</sub> = 0, V <sub>VFF</sub> = 3 V		40	70	mV
Vcs <sub>ofst</sub>		V <sub>MULT</sub> = 3 V, V <sub>VFF</sub> = 3 V		20		IIIV
Boost indu	ctor saturation detector			•		
V <sub>CS_th</sub>	Threshold on current sense	(3)	1.6	1.7	1.8	٧
I <sub>INV</sub>	E/A input pull-up current	After V <sub>CS</sub> > V <sub>CS_th</sub> , before restarting	7	10	13	μΑ
PFC_OK fu	inctions	1		1	I	
I <sub>PFC_OK</sub>	Input bias current	V <sub>PFC_OK</sub> = 0 to 2.6 V		-0.1	-1	μΑ
V <sub>PFC_OK_C</sub>	Clamp voltage	I <sub>PFC_OK</sub> = 1 mA	9	9.5		V
V <sub>PFC_OK_S</sub>	OVP threshold	(1) voltage rising	2.435	2.5	2.565	V
V <sub>PFC_OK_R</sub>	Restart threshold after OVP	(1) voltage falling	2.34	2.4	2.46	V
V <sub>PFC_OK_D</sub>	Disable threshold	(1) voltage falling	0.12		0.35	V
V <sub>PFC_OK_D</sub>	Disable threshold	(1) voltage falling T <sub>J</sub> = 25 °C	0.17	0.23	0.29	٧

Table 4. Electrical characteristics (continued)

Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit
V <sub>PFC_OK_E</sub>	Enable threshold	(1) voltage rising	0.15		0.38	V
V <sub>PFC_OK_E</sub>	Enable threshold	<sup>(1)</sup> voltage rising Tj = 25 °C	0.21	0.27	0.32	٧
V <sub>FFD</sub>	Feedback failure detection threshold (V <sub>INV</sub> falling)	V <sub>PFC_OK</sub> = V <sub>PFC_OK_S</sub>	1.61	1.66	1.71	mV
Zero curre	nt detector					
V <sub>ZCDH</sub>	Upper clamp voltage	I <sub>ZCD</sub> = 2.5 mA	5.0	5.7		٧
V <sub>ZCDL</sub>	Lower clamp voltage	I <sub>ZCD</sub> = - 2.5 mA	-0.3	0	0.3	V
V <sub>ZCDA</sub>	Arming voltage (positive-going edge)		1.1	1.4	1.9	V
V <sub>ZCDT</sub>	Triggering voltage (negative-going edge)		0.5	0.7	0.9	V
I <sub>ZCDb</sub>	Input bias current	V <sub>ZCD</sub> = 1 to 4.5 V			1	μΑ
I <sub>ZCDsrc</sub>	Source current capability		-2.5	-4		mA
I <sub>ZCDsnk</sub>	Sink current capability		2.5	5		mA
Tracking be	oost function					
ΔV	Dropout voltage VVFF-VTBO	I <sub>TBO</sub> = 0.2 mA	-20		20	mV
I <sub>TBO</sub>	Linear operation		0		0.2	mA
	I <sub>INV</sub> -I <sub>TBO</sub> current mismatch	$I_{TBO} = 25 \mu A \text{ to } 0.2 \text{mA}$	-5.5		1.0	%
	I <sub>INV</sub> -I <sub>TBO</sub> current mismatch	$I_{TBO}$ = 25 µA to 0.2mA $T_J$ = 25 °C	-4.0		+0	%
V <sub>TBOclamp</sub>	Clamp voltage	<sup>(3)</sup> V <sub>VFF</sub> = 4 V	2.9	3	3.1	٧
I <sub>TBO_Pull</sub>	Pull-up current	$V_{TBO} = 1 V$ $V_{FF} = V_{MULT} = 0 V$			2	μΑ
PWM_STO	P	•				
lleak	High level leakage current	V <sub>PWM_STOP</sub> = Vcc			1	μΑ
$V_{L}$	Low level	I <sub>PWM_STOP</sub> = 0.5 mA			1	٧
RUN functi	on			•		
I <sub>RUN</sub>	Input bias current	V <sub>RUN</sub> = 0 to 3 V			-1	μΑ
V <sub>DIS</sub>	Disable threshold	(3) voltage falling	0.745	0.8	0.855	٧
V <sub>EN</sub>	Enable threshold	(3) voltage rising	0.845	0.88	0.915	٧
Start-up tin	ner	•	1		•	
t <sub>START_DEL</sub>	Start-up delay	First cycle after wake-up	25	50	75	μs
	Timer period		75	150	300	
t <sub>START</sub>		Restart after V <sub>CS</sub> > V <sub>CS th</sub>	150	300	600	μs

Table 4. Electrical characteristics (continued)

Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit
Voltage fee	edforward		•	•		
$V_{VFF}$	Linear operation range		0.8		3	V
ΔV	Dropout V <sub>MULTpk</sub> -V <sub>VFF</sub>	Vcc < Vcc <sub>On</sub>			800	m)/
		Vcc > or = to Vcc <sub>On</sub>			20	mV
$\Delta V_{VFF}$	Line drop detection threshold	Below peak value	40	70	100	mV
$\Delta V_{VFF}$	Line drop detection threshold	Below peak value T <sub>J</sub> = 25 °C	50	70	90	mV
	latamat diada ana madatan	T <sub>J</sub> = 25 °C	7.5	10	12.5	- kΩ
R <sub>DISCH</sub>	Internal discharge resistor		5		20	- K12
V <sub>VFF</sub>	Linear operation range		0.8		3	V
PWM_LAT	СН					
lleak	Low level leakage current	V <sub>PWM_LATCH</sub> = 0			-1	μΑ
V <sub>H</sub>	High level	I <sub>PWM_LATCH</sub> = -0.5 mA	4.5			V
V <sub>H</sub>	High level	I <sub>PWM_LATCH</sub> = -0.25 mA Vcc = Vcc <sub>Off</sub>	2.5			V
V <sub>H</sub>	High level	$I_{PWM\_LATCH}$ = -0.25 mA Vcc = Vcc <sub>Off</sub> T <sub>J</sub> = 25 °C	2.8			V
Gate drive	r					•
V <sub>OL</sub>	Output low voltage	I <sub>sink</sub> = 100 mA		0.6	1.2	V
V <sub>OH</sub>	Output high voltage	I <sub>source</sub> = 5 mA	9.8	10.3		V
I <sub>srcpk</sub>	Peak source current		-0.6			Α
I <sub>snkpk</sub>	Peak sink current		0.8			Α
t <sub>f</sub>	Voltage fall time			30	60	ns
t <sub>r</sub>	Voltage rise time			45	110	ns
V <sub>Oclamp</sub>	Output clamp voltage	I <sub>source</sub> = 5 mA; Vcc = 20 V	10	12	15	V
	UVLO saturation	Vcc= 0 to V <sub>CCon</sub> , I <sub>sink</sub> = 2 mA			1.1	V

<sup>1.</sup> Parameters tracking each other

$$V_{CS} = V_{CS\_Ofst} + K_M \cdot \frac{V_{MULT} \cdot \left(V_{COMP} - 2.5\right)}{V_{VFF}^2}$$

3. Parameters tracking each other

<sup>2.</sup> The multiplier output is given by:

# 5 Typical electrical performance

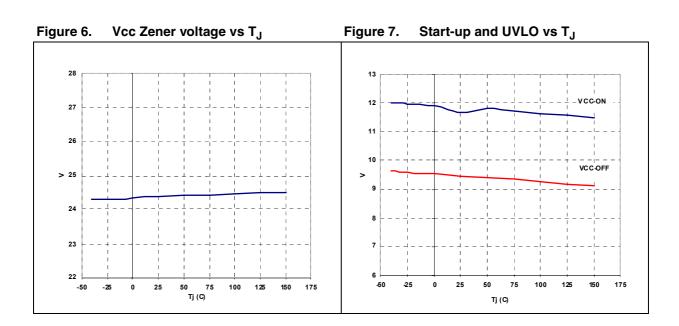
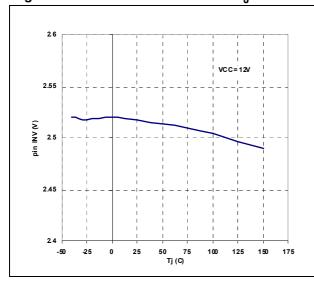


Figure 8. Feedback reference vs T<sub>J</sub>

Figure 9. E/A output clamp levels vs T<sub>J</sub>



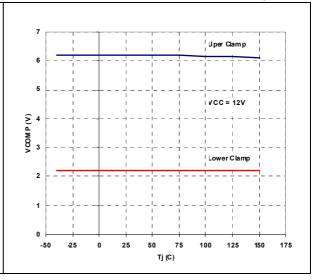
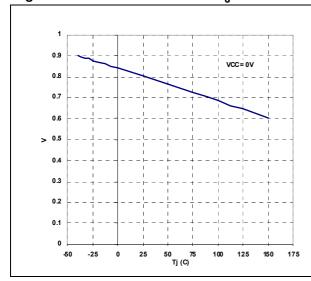


Figure 10. UVLO saturation vs T<sub>J</sub>

Figure 11. OVP levels vs T<sub>J</sub>



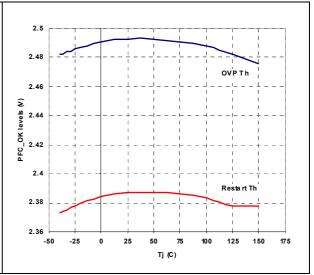


Figure 12. Inductor saturation threshold vs  $T_J$  Figure 13. Vcs clamp vs  $T_J$ 

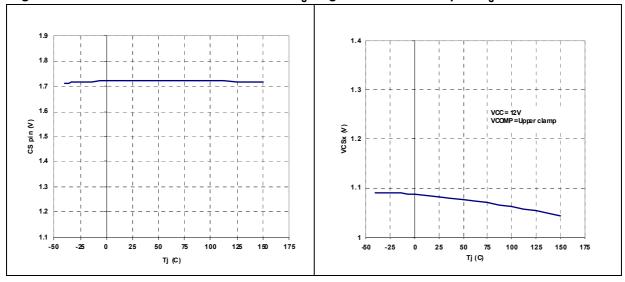


Figure 14. ZCD sink/source capability vs T<sub>J</sub> Figure 15. ZCD clamp level vs T<sub>J</sub>

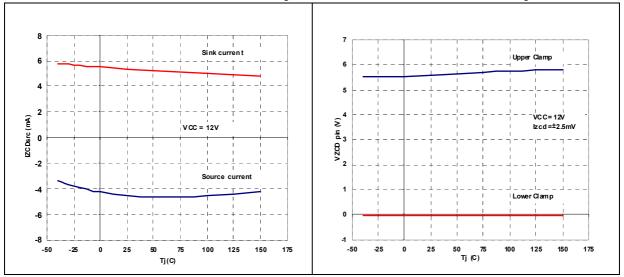
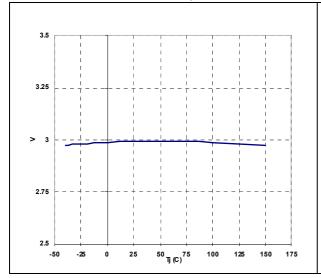


Figure 16. TBO clamp vs T<sub>J</sub>

Figure 17.  $V_{VFF}$  -  $V_{TBO}$  dropout vs  $T_J$ 



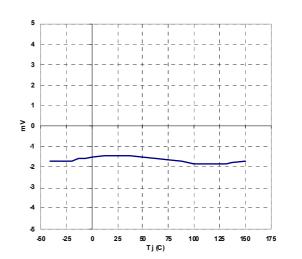
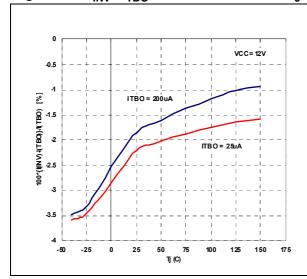


Figure 18.  $I_{INV}$  -  $I_{TBO}$  current mismatch vs  $T_J$  Figure 19.  $I_{INV}$  -  $I_{TBO}$  mismatch vs  $I_{TBO}$  current



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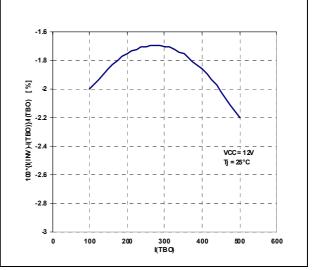
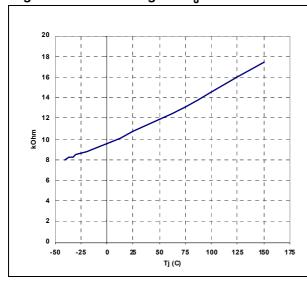


Figure 20. R discharge vs T<sub>J</sub>

Figure 21. Line drop detection threshold vs T<sub>J</sub>



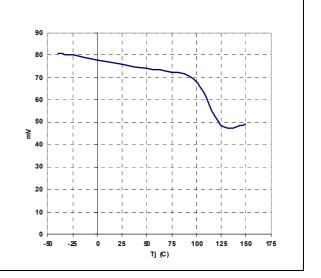
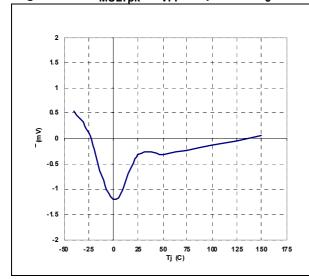


Figure 22.  $V_{MULTpk}$  -  $V_{VFF}$  dropout vs  $T_J$ 

Figure 23. PFC\_OK threshold vs T<sub>J</sub>



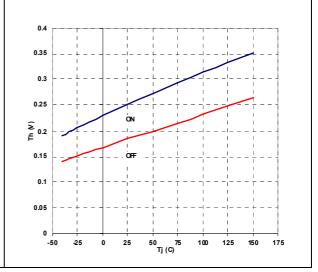
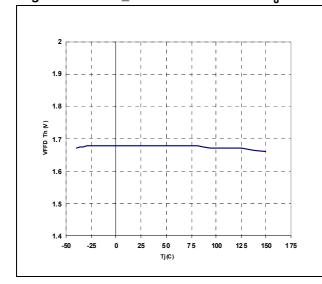


Figure 24. PFC\_OK FFD threshold vs T<sub>J</sub>

Figure 25. PWM\_LATCH high saturation vs T<sub>J</sub>



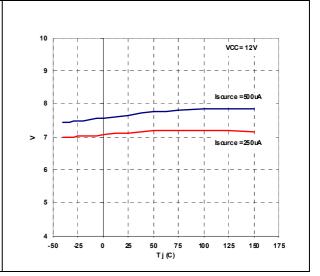
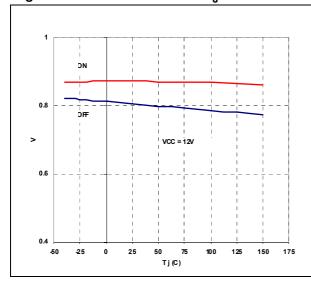


Figure 26. RUN threshold vs T<sub>J</sub>

Figure 27. PWM\_STOP low saturation vs T<sub>J</sub>



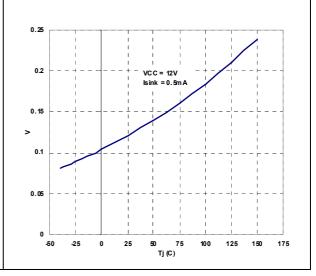
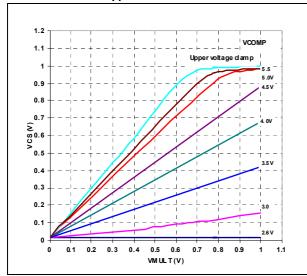


Figure 28. Multiplier characteristics  $@V_{FF} = 1 V$ 

Figure 29. Multiplier characteristics  $@V_{FF} = 3 V$ 



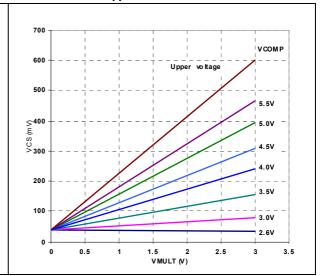
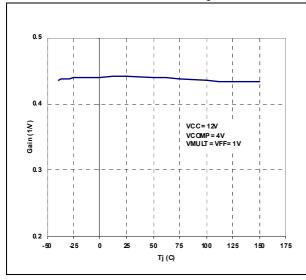


Figure 30. Multiplier gain vs T<sub>J</sub>

Figure 31. Gate drive clamp vs T<sub>J</sub>



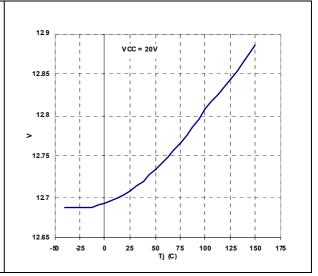


Figure 32. Gate drive output saturation vs T<sub>J</sub> Figure 33. Delay to output vs T<sub>J</sub>

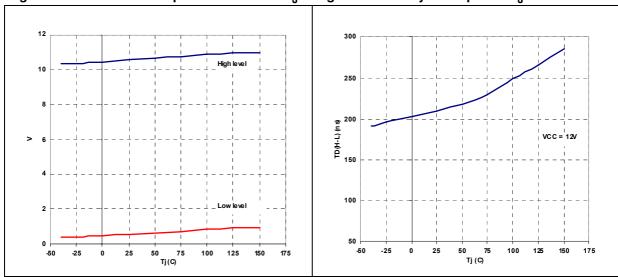


Figure 34. Start-up timer period vs  $T_J$ 

Figure 35. HV start voltage vs T<sub>J</sub>

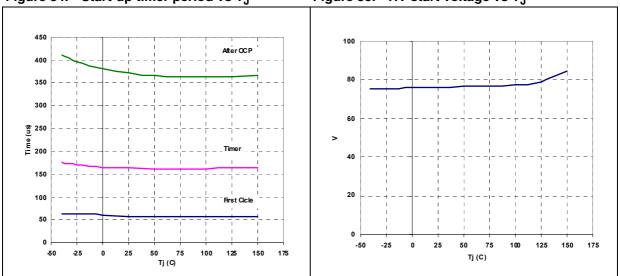
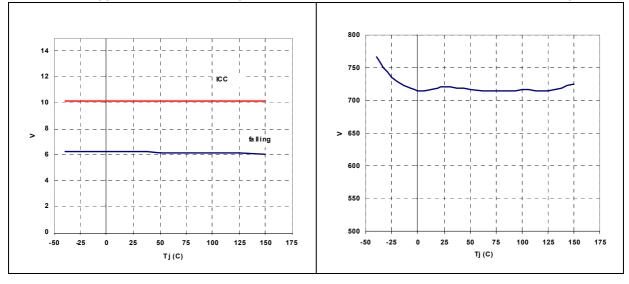


Figure 36. V<sub>CC</sub> restart voltage vs T<sub>J</sub>

Figure 37. HV breakdown voltage vs T<sub>J</sub>



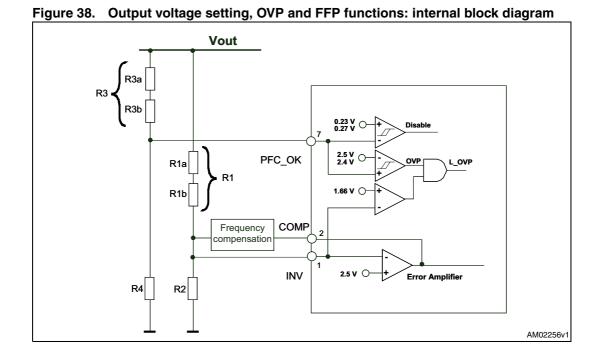
### 6 Application information

#### 6.1 Overvoltage protection

Normally, the voltage control loop keeps the output voltage Vo of the PFC pre-regulator close to its nominal value, set by the ratio of the resistors R1 and R2 of the output divider. A pin of the device (PFC\_OK) has been dedicated to monitor the output voltage with a separate resistor divider (R3 high, R4 low, see *Figure 38*). This divider is selected so that the voltage at the pin reaches 2.5 V if the output voltage exceeds a preset value, usually larger than the maximum Vo that can be expected.

Example:  $V_O = 400 \text{ V}$ ,  $V_{OX} = 434 \text{ V}$ . Select:  $R3 = 8.8 \text{ M}\Omega$ ; then:  $R4 = 8.8 \text{ M}\Omega \cdot 2.5/(434-2.5) = 51 \text{ k}\Omega$ .

When this function is triggered, the gate drive activity is immediately stopped until the voltage on the pin PFC\_OK drops below 2.4 V. Notice that R1, R2, R3 and R4 can be selected without any constraints. The unique criterion is that both dividers have to sink a current from the output bus which needs to be significantly higher than the bias current of both INV and PFC\_OK pins.



#### 6.2 Feedback failure protection (FFP)

The OVP function above described handles "normal" over voltage conditions, i.e. those resulting from an abrupt load/line change or occurring at start-up. In case the overvoltage is generated by a feedback disconnection, for instance when the upper resistor of the output divider (R1) fails open,comparator detects the voltage at pin INV. If the voltage is lower than 1.66 V and the OVP is active, the FFP is triggered, the gate drive activity is immediately stopped, the device is shut down, its quiescent consumption is reduced below 180  $\mu$ A and the condition is latched as long as the supply voltage of the IC is above the UVLO threshold. At the same time the pin PWM\_LATCH is asserted high. PWM\_LATCH is an open source output able to deliver 2.8 V minimum with 0.25 mA load, intended for tripping a latched shutdown function of the PWM controller IC in the cascaded dc-dc converter, so that the entire unit is latched off. To restart the system it is necessary to recycle the input power, so that the Vcc voltage of both the L6563H goes below 6V and that one of the PWM controller goes below its UVLO threshold.

The pin PFC\_OK doubles its function as a not-latched IC disable: a voltage below 0.23V shutdown the IC, reducing its consumption below 2 mA. In this case both PWM\_STOP and PWM\_LATCH keep their high impedance status. To restart the IC simply let the voltage at the pin go above 0.27 V.

Note that these functions offer a complete protection against not only feedback loop failures or erroneous settings, but also against a failure of the protection itself. Either resistor of the PFC\_OK divider failing short or open or a PFC\_OK pin floating results in shutting down the IC and stopping the pre-regulator.

### 6.3 Voltage feedforward

The power stage gain of PFC pre-regulators varies with the square of the RMS input voltage. So does the crossover frequency fc of the overall open-loop gain because the gain has a single pole characteristic. This leads to large trade-offs in the design.

For example, setting the gain of the error amplifier to get fc = 20 Hz @ 264 Vac means having fc 4 Hz @ 88 Vac, resulting in a sluggish control dynamics. Additionally, the slow control loop causes large transient current flow during rapid line or load changes that are limited by the dynamics of the multiplier output. This limit is considered when selecting the sense resistor to let the full load power pass under minimum line voltage conditions, with some margin. But a fixed current limit allows excessive power input at high line, whereas a fixed power limit requires the current limit to vary inversely with the line voltage.

Voltage Feedforward can compensate for the gain variation with the line voltage and allow minimizing all of the above-mentioned issues. It consists of deriving a voltage proportional to the input RMS voltage, feeding this voltage into a squarer/divider circuit (1/V2 corrector) and providing the resulting signal to the multiplier that generates the current reference for the inner current control loop (see *Figure 39*).

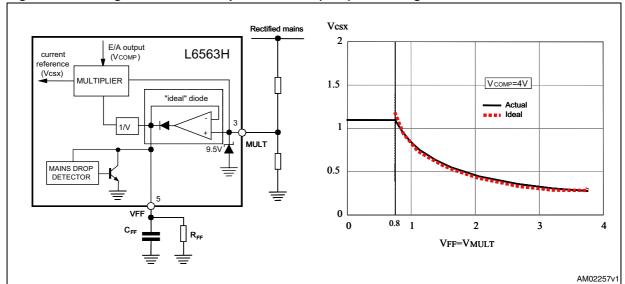


Figure 39. Voltage feedforward: squarer-divider (1/V2) block diagram and transfer characteristic

In this way a change of the line voltage causes an inversely proportional change of the half sine amplitude at the output of the multiplier (if the line voltage doubles the amplitude of the multiplier output is halved and vice versa) so that the current reference is adapted to the new operating conditions with (ideally) no need for invoking the slow dynamics of the error amplifier. Additionally, the loop gain is constant throughout the input voltage range, which improves significantly dynamic behavior at low line and simplifies loop design.

Actually, deriving a voltage proportional to the RMS line voltage implies a form of integration, which has its own time constant. If it is too small the voltage generated is affected by a considerable amount of ripple at twice the mains frequency that causes distortion of the current reference (resulting in high THD and poor PF); if it is too large there is a considerable delay in setting the right amount of feedforward, resulting in excessive overshoot and undershoot of the pre-regulator's output voltage in response to large line voltage changes. Clearly a trade-off was required.

The L6563H realizes a NEW voltage feed forward that, with a technique that makes use of just two external parts, strongly minimizes this time constant trade-off issue whichever voltage change occurs on the mains, both surges and drops. A capacitor C<sub>FF</sub> and a resistor RFF, both connected from the pin VFF (#5) to ground, complete an internal peak-holding circuit that provides a DC voltage equal to the peak of the rectified sine wave applied on pin MULT (#3). In this way, in case of sudden line voltage rise, C<sub>FF</sub> is rapidly charged through the low impedance of the internal diode; in case of line voltage drop, an internal "mains drop" detector enables a low impedance switch which suddenly discharges CFF avoiding long settling time before reaching the new voltage level. The discharge of CFF is stopped as its voltage equals the voltage on pin MULT or if the voltage on pin RUN (in case it is connected to VFF) falls below 0.88V, to prevent the "Brownout protection" function from being improperly activated (see "Power management/housekeeping functions" section).

As a result of the VFF pin functionality, an acceptably low steady-state ripple and low current distortion can be achieved with a limited undershoot or overshoot on the pre-regulator's output.

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The twice-mains-frequency  $(2 \cdot f_L)$  ripple appearing across  $C_{FF}$  is triangular with a peak-to-peak amplitude that, with good approximation, is given by:

$$\Delta V_{FF} = \frac{2 V_{MULTpk}}{1 + 4 f_I R_{FF} C_{FF}}$$

where  $f_L$  is the line frequency. The amount of 3rd harmonic distortion introduced by this ripple, related to the amplitude of its  $2 \cdot f_L$  component, is:

$$D_3\% = \frac{100}{2\pi f_L R_{FF} C_{FF}}$$

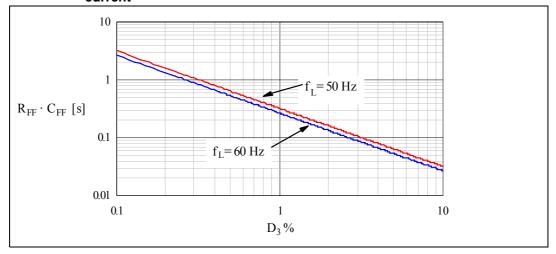
*Figure 40* shows a diagram that helps choose the time constant  $R_{FF} \cdot C_{FF}$  based on the amount of maximum desired 3rd harmonic distortion.

Note that there is a minimum value for the time constant  $R_{FF} \cdot C_{FF}$  below which improper activation of the  $V_{FF}$  fast discharge may occur. In fact, the twice-mains-frequency ripple across  $C_{FF}$  under steady state conditions must be lower than the minimum line drop detection threshold ( $\Delta V_{VFF\_min} = 40 \text{ mV}$ ). Therefore:

$$R_{FF} \cdot C_{FF} > \frac{2 \frac{V_{MULTpk\_max}}{\Delta V_{VFF\_min}} - 1}{4 f_{L\_min}}$$

Always connect  $R_{FF}$  and  $C_{FF}$  to the pin, the IC will not work properly if the pin is either left floating or connected directly to ground.

Figure 40. R<sub>FF</sub>·C<sub>FF</sub> as a function of 3rd harmonic distortion introduced in the input current



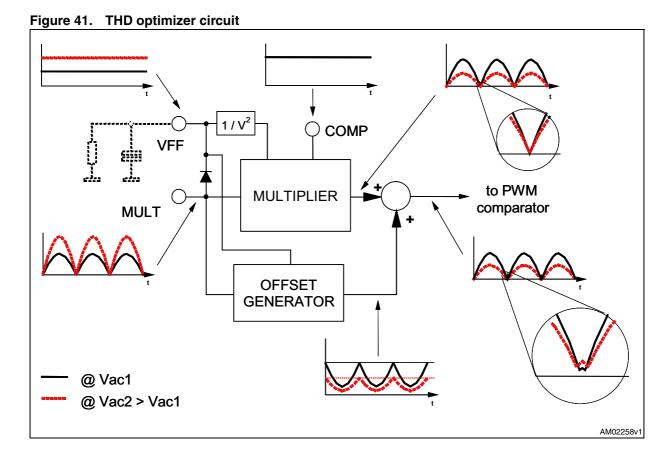
## 6.4 THD optimizer circuit

The L6563H is provided with a special circuit that reduces the conduction dead-angle occurring to the AC input current near the zero-crossings of the line voltage (crossover distortion). In this way the THD (total harmonic distortion) of the current is considerably reduced.

A major cause of this distortion is the inability of the system to transfer energy effectively when the instantaneous line voltage is very low. This effect is magnified by the high-frequency filter capacitor placed after the bridge rectifier, which retains some residual voltage that causes the diodes of the bridge rectifier to be reverse-biased and the input current flow to temporarily stop.

To overcome this issue the device forces the PFC pre-regulator to process more energy near the line voltage zero-crossings as compared to that commanded by the control loop. This results in both minimizing the time interval where energy transfer is lacking and fully discharging the high-frequency filter capacitor after the bridge.

Figure 41 shows the internal block diagram of the THD optimizer circuit.



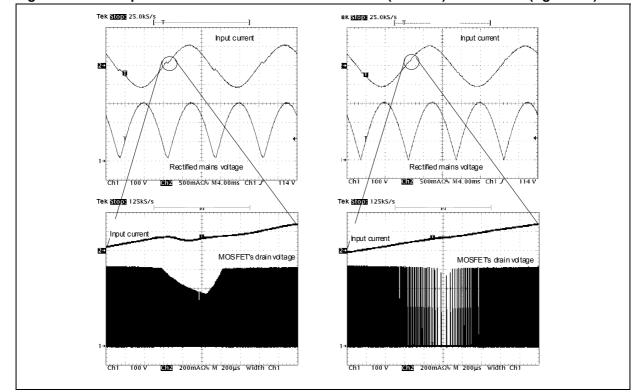


Figure 42. THD optimization: standard TM PFC controller (left side) and L6563H (right side)

Essentially, the circuit artificially increases the ON-time of the power switch with a positive offset added to the output of the multiplier in the proximity of the line voltage zero-crossings. This offset is reduced as the instantaneous line voltage increases, so that it becomes negligible as the line voltage moves toward the top of the sinusoid. Furthermore the offset is modulated by the voltage on the VFF pin (see "Voltage Feedforward" section) so as to have little offset at low line, where energy transfer at zero crossings is typically quite good, and a larger offset at high line where the energy transfer gets worse.

The effect of the circuit is shown in *Figure 42*, where the key waveforms of a standard TM PFC controller are compared to those of this chip.

To take maximum benefit from the THD optimizer circuit, the high-frequency filter capacitor after the bridge rectifier should be minimized, compatibly with EMI filtering needs. A large capacitance, in fact, introduces a conduction dead-angle of the AC input current in itself - even with an ideal energy transfer by the PFC pre-regulator - thus reducing the effectiveness of the optimizer circuit.

## 6.5 Tracking boost function

In some applications it may be advantageous to regulate the output voltage of the PFC preregulator so that it tracks the RMS input voltage rather than at a fixed value like in conventional boost pre-regulators. This is commonly referred to as "tracking boost" or "follower boost" approach.

With the L6563H this can be realized by connecting a resistor (RT) between the TBO pin and ground. The TBO pin presents a DC level equal to the peak of the MULT pin voltage and is then representative of the mains RMS voltage. The resistor defines a current, equal to

V(TBO)/RT, that is internally 1:1 mirrored and sunk from pin INV (#1) input of the L6563H's error amplifier. In this way, when the mains voltage increases the voltage at TBO pin increases as well and so does the current flowing through the resistor connected between TBO and GND. Then a larger current is sunk by INV pin and the output voltage of the PFC pre-regulator is forced to get higher. Obviously, the output voltage moves in the opposite direction if the input voltage decreases.

To avoid undesired output voltage rise should the mains voltage exceed the maximum specified value, the voltage at the TBO pin is clamped at 3V. By properly selecting the multiplier bias it is possible to set the maximum input voltage above which input-to-output tracking ends and the output voltage becomes constant. If this function is not used, leave the pin open: the device regulates a fixed output voltage.

Starting from the following data:

- Vin<sub>1</sub> = minimum specified input RMS voltage;
- Vin<sub>2</sub> = maximum specified input RMS voltage;
- Vo<sub>1</sub> = regulated output voltage @ Vin = Vin<sub>1</sub>;
- Vo<sub>2</sub> = regulated output voltage @ Vin = Vin<sub>2</sub>;
- Vox = absolute maximum limit for the regulated output voltage;

to set the output voltage at the desired values use the following design procedure:

Determine the input RMS voltage Vinclamp that produces Vo = Vox:

$$Vin_{clamp} = \frac{Vox - Vo_1}{Vo_2 - Vo_1} \cdot Vin_2 - \frac{Vox - Vo_2}{Vo_2 - Vo_1} \cdot Vin_1$$

and choose a value  $Vin_x$  such that  $Vin_2 \le Vinx < Vinclamp$ . This results in a limitation of the output voltage range below Vox (it is equal Vox if one chooses  $Vin_x = Vin_{clamp}$ )

2. Determine the divider ratio of the MULT pin (#3) bias:

$$k = \frac{3}{\sqrt{2} \cdot Vin_x}$$

and check that at minimum mains voltage Vin1 the peak voltage on pin 3 is greater than 0.65 V.

- 3. Determine R1, the upper resistor of the output divider, for instance 3 M $\Omega$ .
- 4. Calculate the lower resistor R2 of the output divider and the adjustment resistor RT:

$$\begin{cases} R2 = 2.5 \cdot R1 \cdot \frac{Vin_2 - Vin_1}{\left(Vo_1 - 2.5\right) \cdot Vin_2 - \left(Vo_2 - 2.5\right) \cdot Vin_1} \\ R_T = \sqrt{2} \cdot k \cdot R1 \cdot \frac{Vin_2 - Vin_1}{Vo_2 - Vo_1} \end{cases}$$

Check that the maximum current sourced by the TBO pin (#6) does not exceed the maximum specified (0.2 mA):

$$I_{TBO\,max} = \frac{3}{R_T} \le 0.2 \cdot 10^{-3}$$

Figure 43 shows the internal block diagram of the tracking boost function.

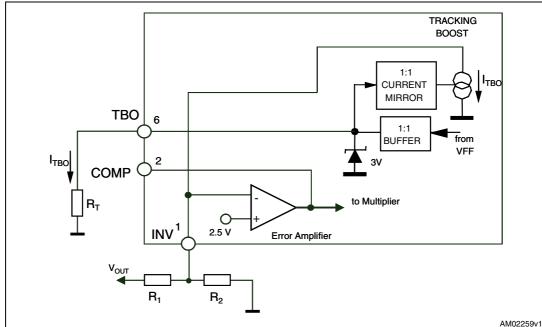
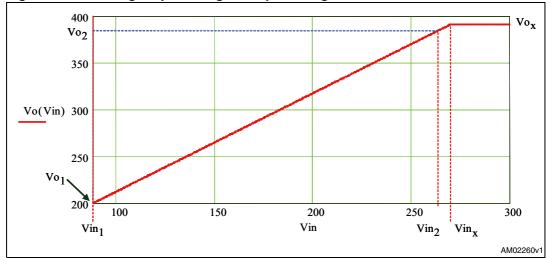


Figure 43. Tracking boost block





#### 6.6 Inductor saturation detection

Boost inductor's hard saturation may be a fatal event for a PFC pre-regulator: the current upslope becomes so large (50-100 times steeper, see *Figure 45*) that during the current sense propagation delay the current may reach abnormally high values. The voltage drop caused by this abnormal current on the sense resistor reduces the gate-to-source voltage, so that the MOSFET may work in the active region and dissipate a huge amount of power, which leads to a catastrophic failure after few switching cycles.

However, in some applications such as ac-dc adapters, where the PFC pre-regulator is turned off at light load for energy saving reasons, even a well-designed boost inductor may

occasionally slightly saturate when the PFC stage is restarted because of a larger load demand. This happens when the restart occurs at an unfavorable line voltage phase, i.e. when the output voltage is significantly below the rectified peak voltage. As a result, in the boost inductor the inrush current coming from the bridge rectifier adds up to the switched current and, furthermore, there is little or no voltage available for demagnetization.

To cope with a saturated inductor, the L6563H is provided with a second comparator on the current sense pin (CS, pin 4) that stops the IC if the voltage, normally limited within 1.1 V, exceeds 1.7 V. After that, the IC attempts to restart by the internal starter circuitry; the starter repetition time is twice the nominal value to guarantee lower stress for the inductor and boost diode. Hence, the system safety is considerably increased.

Vcs Vcs Vcs  $\Delta IL$ 1.7V 1.7V 1.7V -₫ ΔIL Multiplier Multiplier Multiplier Output Output Output t Tdelay Tdelay Tdelay Inductor not saturating Inductor slightly saturating Inductor saturating hard

Figure 45. Effect of boost inductor saturation on the MOSFET current and detection method

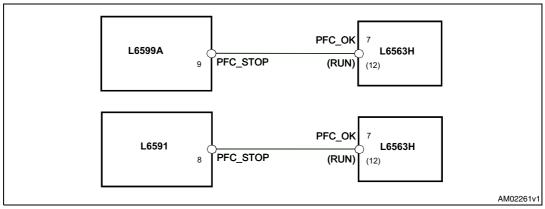
### 6.7 Power management/housekeeping functions

A special feature of this IC is that it facilitates the implementation of the "housekeeping" circuitry needed to co-ordinate the operation of the PFC stage to that of the cascaded DC-DC converter. The functions realized by the housekeeping circuitry ensure that transient conditions like power-up or power down sequencing or failures of either power stage be properly handled.

This device provides some pins to do that. One communication line between the IC and the PWM controller of the cascaded dc-dc converter is the pin PWM\_LATCH (*Figure 47b*), which is normally open (high impedance) when the PFC works properly, and goes high if it loses control of the output voltage (because of a feedback loop disconnection) with the aim of latching off the PWM controller of the cascaded dc-dc converter as well (see "Feedback failure protection" section for more details).

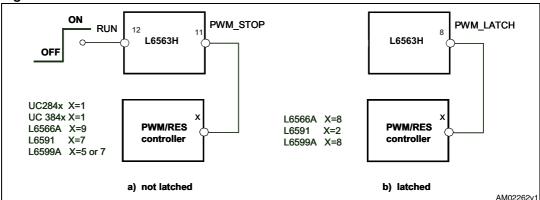
A second communication line can be established via the disable function included in the PFC\_OK pin (see "Feedback failure protection" section for more details). Typically this line is used to allow the PWM controller of the cascaded dc-dc converter to drive in burst mode operation the L6563H in case of light load and to minimize the no-load input consumption. Interface circuits like those are shown in *Figure 46*.

Figure 46. Interface circuits that let dc-dc converter's controller IC drive L6563H in burst mode



The third communication line is the pin PWM\_STOP (#11), which works in conjunction with the pin RUN (#12). The purpose of the PWM\_STOP pin is to inhibit the PWM activity of both the PFC stage and the cascaded dc-dc converter. The pin is an open collector, normally open, that goes low if the device is disabled by a voltage lower than 0.8 V on the RUN pin. The pin goes again open if the voltage on pin RUN exceeds 0.88 V. It is important to point out that this function works correctly in systems where the PFC stage is the master and the cascaded dc-dc converter is the slave or, in other words, where the PFC stage starts first, powers both controllers and enables/disables the operation of the dc-dc stage. The pin RUN can be used to start and stop the main converter. In the simplest case, to enable/disable the PWM controller the pin PWM\_STOP can be connected to the output of the error amplifier (Figure 47a).

Figure 47. Interface circuits that let the L6563H switch on or off a PWM controller



If the chip is provided with a soft-start pin, it is possible to delay the start-up of the dc-dc stage with respect to that of the PFC stage, which is often desired, as described in *Figure 48*. An underlying assumption in order for that to work properly is that the UVLO thresholds of the PWM controller are certainly higher than those of the L6563H.

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ON RUN 12 L6563H 11 PWM\_STOP

L6566A X=14
L6591 X=4
L6599A X=1 C<sub>SS</sub>

AM02263v1

Figure 48. Interface circuits for power up sequencing when dc-dc has the SS function

If this is not the case or it is not possible to achieve a start-up delay long enough (because this prevents the dc-dc stage from starting up correctly) or, simply, the PWM controller is devoid of soft start, the arrangement of *Figure 49* lets the dc-dc converter start-up when the voltage generated by the PFC stage reaches a preset value. The technique relies on the UVLO thresholds of the PWM controller.

HV bus Supply rai BC337 L5991/A: X=8+9 UC284x: X=7 UC384x: X=7 10  $k\Omega$ I 6565 X=8 L6598: X=12 PWM STOP Vcc BC558C ٧Z 16 11 **PWM** RUN <sub>12</sub> L6563H controller '욧 Vcc Off < VZ < Vccmax AM02264v

Figure 49. Interface circuits for actual power-up sequencing (master PFC)

Another possible use of the RUN and PWM\_STOP pins (again, in systems where the PFC stage is the master) is the brownout protection, thanks to the hysteresis provided.

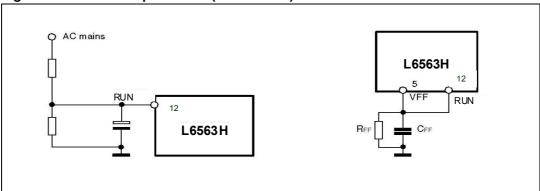
The brownout protection is basically a not-latched device shutdown function that is activated when a condition of mains undervoltage is detected. This condition may cause overheating of the primary power section due to an excess of RMS current. Brownout can also cause the PFC pre-regulator to work open loop and this could be dangerous to the PFC stage itself and the downstream converter, should the input voltage return abruptly to its rated value. Another problem is the spurious restarts that may occur during converter power down and that cause the output voltage of the converter not to decay to zero monotonically. For these reasons it is usually preferable to shutdown the unit in case of brownout.

IC shutdown upon brownout can be easily realized as shown in Figure 50. The scheme on the left is of general use, that one on the right can be used if the bias levels of the multiplier and the  $R_{FF}$ - $C_{FF}$  time constant are compatible with the specified brownout level and with the specified holdup time respectively. In this latest case, an additional resistor voltage divider and one capacitor are not needed.

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In table 1 it is possible to find a summary of all of the above mentioned working conditions that cause the device to stop operating.

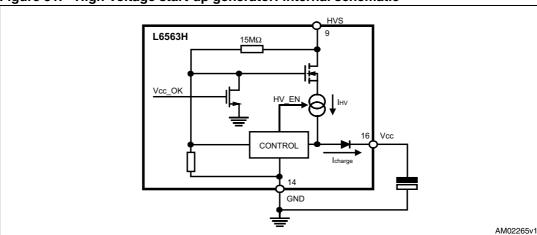
Figure 50. Brownout protection (master PFC)



## 6.8 High-voltage start-up generator

*Figure 51* shows the internal schematic of the high-voltage start-up generator (HV generator). It is made up of a high-voltage N-channel FET, whose gate is biased by a 15 M $\Omega$  resistor, with a temperature-compensated current generator connected to its source.

Figure 51. High-voltage start-up generator: internal schematic



The HV generator is physically located on a separate chip, made with BCD off-line technology able to withstand 700 V, controlled by a low-voltage chip, where all of the control functions reside.

With reference to the timing diagram of *Figure 52*, when power is first applied to the converter the voltage on the bulk capacitor (Vin) builds up and, at about 80 V, the HV generator is enabled to operate (HV\_EN is pulled high) so that it draws about 1 mA. This current, minus the device's consumption, charges the bypass capacitor connected from pin Vcc (16) to ground and makes its voltage rise almost linearly.

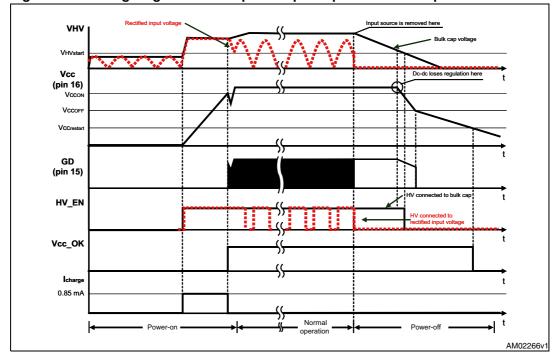


Figure 52. Timing diagram: normal power-up and power-down sequences

As the Vcc voltage reaches the start-up threshold (12 V typ.) the low-voltage chip starts operating and the HV generator is cut off by the Vcc\_OK signal asserted high. The device is powered by the energy stored in the Vcc capacitor until the self-supply circuit (we assume that it is made with an auxiliary winding in the transformer of the cascaded dc-dc converter and a steering diode) develops a voltage high enough to sustain the operation. The residual consumption of this circuit is just the one on the 15 M $\Omega$  resistor (10 mW at 400 Vdc), typically 50-70 times lower, under the same conditions, as compared to a standard start-up circuit made with external dropping resistors.

At converter power-down the dc-dc converter loses regulation as soon as the input voltage is so low that either peak current or maximum duty cycle limitation is tripped. Vcc then drops and stops IC activity as it falls below the UVLO threshold (9.5 V typ.). The Vcc\_OK signal is de-asserted as the Vcc voltage goes below a threshold VCCrestart located at about 6 V. The HV generator can now restart. However, if Vin < VHVstart, HV\_EN is de-asserted too and the HV generator is disabled. This prevents converter's restart attempts and ensures monotonic output voltage decay at power-down in systems where brownout protection (see the relevant section) is not used.

If the device detects a fault due to feedback failure the pin PWM\_LATCH is asserted high (see "Feedback failure protection" section for more details) and, in order to maintain alive this signal to be provided to the DC-DC converter, the internal VCCrestart is brought up to over the VccOff (Turn-off threshold). As a result, shown in *Figure 53*, the voltage at pin Vcc, oscillates between its turn-on and turn-off thresholds until the HV bus is recycled and drops below the start up threshold of the HV generator.

The High Voltage Start-up circuitry is capable to guarantee a safe behavior in case of short circuit present on the dc-dc output when the Vcc of both controllers are generated by the same auxiliary winding. The *Figure 54* shows how the PFC manages the Vcc cycling and the associated power transfer. At short circuit the auxiliary circuit is no longer able to sustain the Vcc which start dropping; reaching its VccOFF threshold the IC stops switching, reduces

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consumption and drops more until the Vccrestart threshold is tripped. Now, the high voltage start-up generator restarts and when the Vcc crosses again its turn on threshold the IC starts switching. In this manner the power is transferred from mains to PFC output only during a short time for each Trep cycle.

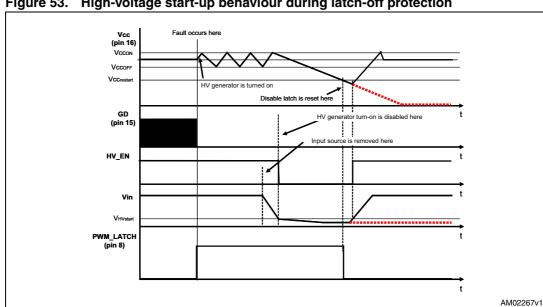


Figure 53. High-voltage start-up behaviour during latch-off protection



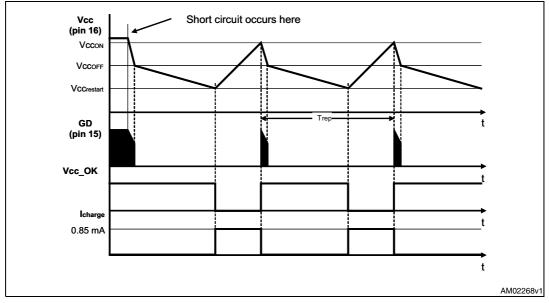


Table 5. Summary of L6563H idle states

Condition	Caused or revealed bey	IC behavior	Restart condition	Typical IC consumption	PWM_LATCH Status	PWM_STOP Status
UVLO	Vcc < Vcc <sub>Off</sub>	Disabled	Vcc > Vcc <sub>On</sub>	90 μA	Off	High
Feedback disconnected	PFC_OK > V <sub>PFC_OK_S</sub> AND INV < 1.66V	Latched	Vcc < Vcc <sub>restart</sub> then Vcc > Vcc <sub>On</sub>	180 μΑ	High	High
Standby	PFC_OK < V <sub>PFC_OK_D</sub>		PFC_OK > V <sub>PFC_OK_E</sub>	1.5 mA	Off	High
AC brownout	RUN < V <sub>DIS</sub>	Stop switching	RUN > V <sub>EN</sub>	1.5 mA	Off	Low
OVP	PFC_OK > V <sub>PFC_OK_S</sub>	3	PFC_OK < V <sub>PFC_OK_R</sub>	2.2 mA	Off	High
Low consumption	COMP < 2.4V	Burst mode	COMP > 2.4V	2.2 mA	Off	High
Saturated boost inductor	Vcs > V <sub>CS_th</sub>	Doubled Tstart	Auto restart	2.2 mA	Off	High

## 7 Application examples and ideas

Figure 55. Demonstration board EVL6563H-100W, wide-range mains: electrical schematic

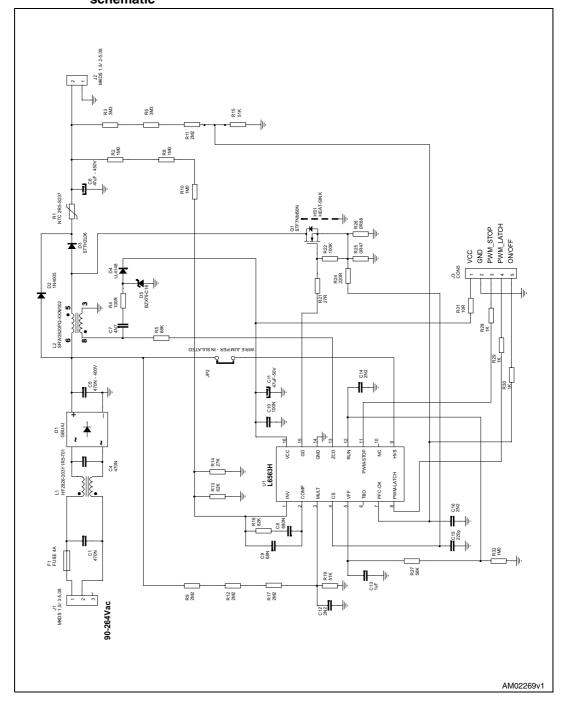


Figure 56. L6563H 100 W TM PFC evaluation board: compliance to EN61000-3-2 standard

Figure 57. L6563H 100 W TM PFC evaluation board: compliance to JEITA-MITI standard

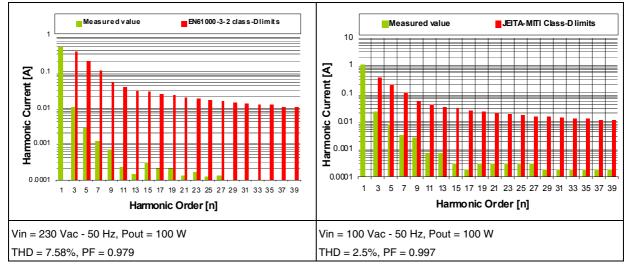
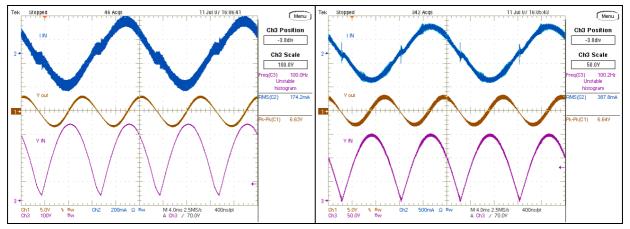


Figure 58. L6563H 100 W TM PFC evaluation board: input current waveform @230-50 Hz - 100 W load

Figure 59. L6563H 100W TM PFC evaluation board: input current waveform @100 V-50 Hz - 100 W load



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Figure 60. EVL90WADP-LLCSR 90W adapter with SRK2000 demonstration board: electrical schematic

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Figure 61. EV150WAIO-LLCSR 150W-12V Adapter with L6563H, L6599A, SRK2000: electrical schematic



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Trata

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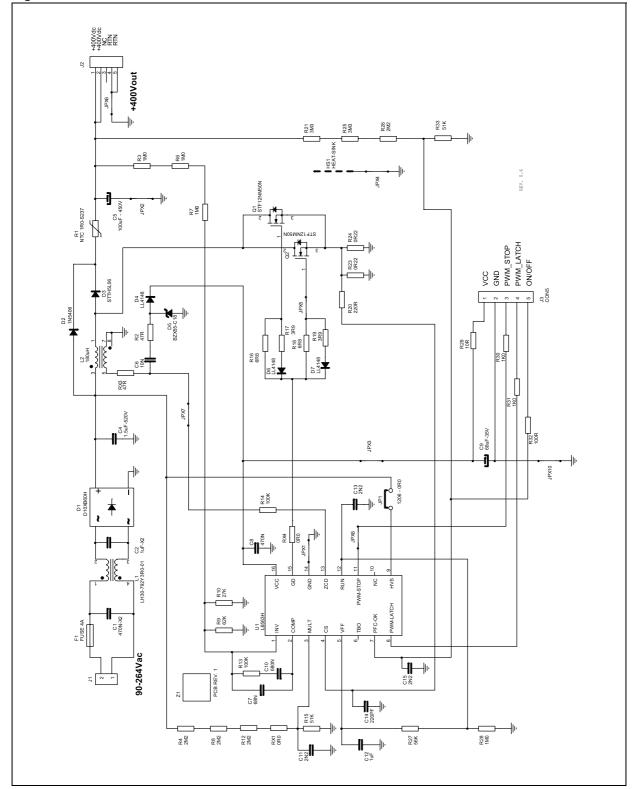


Figure 62. EVL6563H -250W TM PFC demonstration board : electrical schematic

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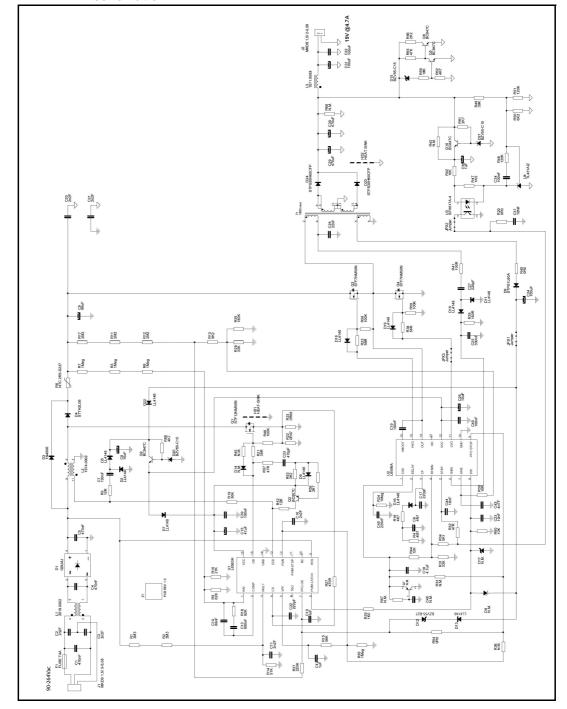


Figure 63. EVL6599A-90WADP 90W Adapter demonstration board: electrical schematic

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## 8 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

Table 6. SO16 mechanical data

Dim.	mm				
Dilli.	Min.	Тур.	Max.		
А			1.75		
A1	0.1		0.25		
A2	1.25				
b	0.31		0.51		
С	0.17		0.25		
D	9.8	9.9	10		
E	5.8	6	6.2		
E1	3.8	3.9	4		
е		1.27			
h	0.25		0.5		
L	0.4		1.27		
k	0		8		
ccc			0.1		

С SEATING PLANE Ε E1 Α1 o €  $\bigcirc$ 200 

Figure 64. SO16 mechanical data

L6563H Ordering codes

# 9 Ordering codes

Table 7. Ordering information

Order codes	Package	Packing	
L6563H	SO16	Tube	
L6563HTR	3010	Tape and reel	

Revision history L6563H

# 10 Revision history

Table 8. Document revision history

Date	Revision	Changes	
22-Jul-2009	1	Initial release.	
01-Feb-2010	2	Updated Table 4 on page 11	
10-Aug-2010	3	Updated	

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